

HD6301V1, HD63A01V1, HD63B01V1 CMOS MCU (Microcomputer Unit)

The HD6301V1 is an 8-bit CMOS single-chip microcomputer unit, Object Code compatible with the HD6801. 4kB ROM, 128 bytes RAM, Serial Communication Interface (SCI), parallel I/O ports and multi function timer are incorporated in the HD6301V1. It is bus compatible with HMCS6800. Execution time of key instructions are improved and several new instructions are added to increase system throughput. The HD6301V1 can be expanded up to 65k bytes. Like the HMCS6800 family, I/O level is TTL compatible with +5.0V single power supply. As HD6301V1 is fabricated by the advanced CMOS process technology, power dissipation is extremely reduced. In addition to that, HD6301V1 has Sleep Mode and Standby Mode at lower power dissipation mode. Therefore flexible low power consumption application is possible.

■ FEATURES

- Object Code Upward Compatible with HD6801 Family
- Abundant On-Chip Functions Compatible with HD6801V0:
4kB ROM, 128 Bytes RAM, 29 Parallel I/O Lines, 2 Lines of Data Strobe, 16-bit Timer, Serial Communication Interface
- Low Power Consumption Mode: Sleep Mode, Standby Mode
- Minimum Instruction Execution Time
 $1\mu\text{s}$ ($f=1\text{MHz}$), $0.67\mu\text{s}$ ($f=1.5\text{MHz}$), $0.5\mu\text{s}$ ($f=2\text{MHz}$)
- Bit Manipulation, Bit Test Instruction
- Protection from System Upset: Address Trap, On-Code Trap
- Up to 65k Words Address Space
- Wide Operation Range
 $V_{CC}=3$ to 6V ($f=0.1\sim 0.5\text{MHz}$),
 $f=0.1$ to 2.0MHz ($V_{CC}=5\text{V}\pm 10\%$)

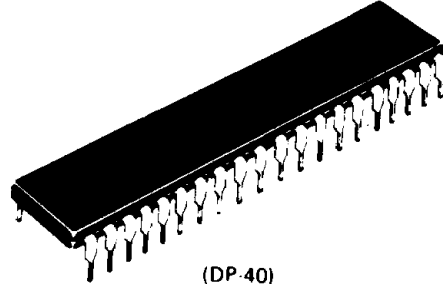
■ TYPE OF PRODUCTS

| Type No. | Bus Timing |
|-----------|------------|
| HD6301V1 | 1 MHz |
| HD63A01V1 | 1.5 MHz |
| HD63B01V1 | 2 MHz |

■ PROGRAM DEVELOPMENT SUPPORT TOOLS

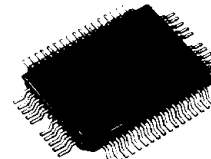
- Cross assembler and C compiler software for IBM PCs and compatibles
- In circuit emulator for use with IBM PCs and compatibles

HD6301V1P, HD63A01V1P, HD63B01V1P



(DP-40)

HD6301V1F, HD63A01V1F, HD63B01V1F



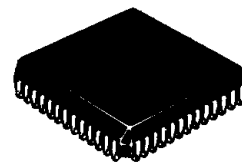
(FP-54)

HD6301V1CG, HD63A01V1CG, HD63B01V1CG



(CG-40)

HD6301V1CP, HD63A01V1CP
HD63B01V1CP



(CP-52)

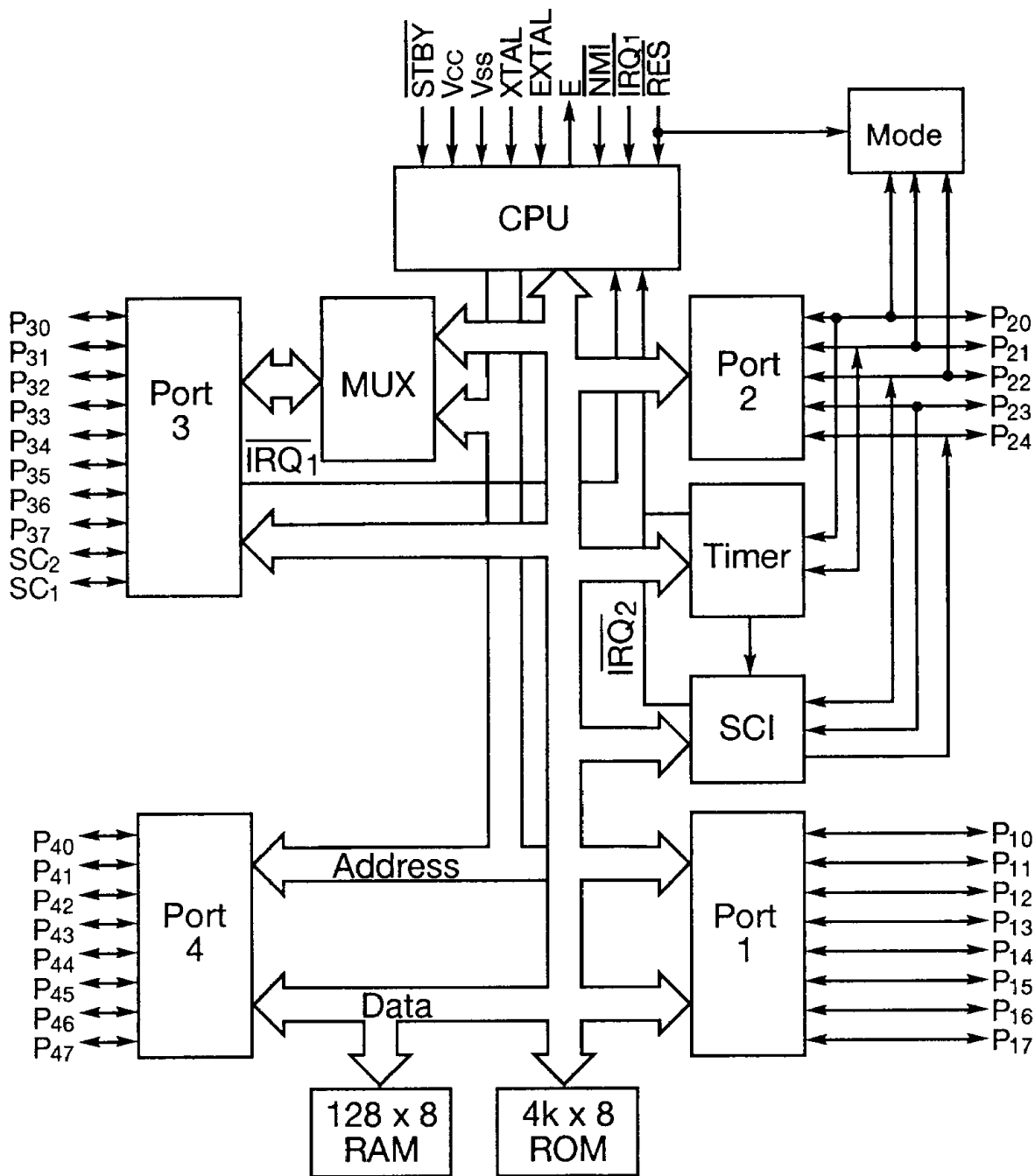
HD6301V1L, HD63A01V1L
HD63B01V1L



(CP-44)

HD6301V1, HD63A01V1, HD63B01V1

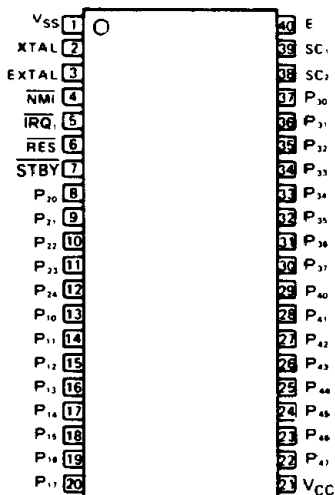
■ BLOCK DIAGRAM



HD6301V1, HD63A01V1, HD63B01V1

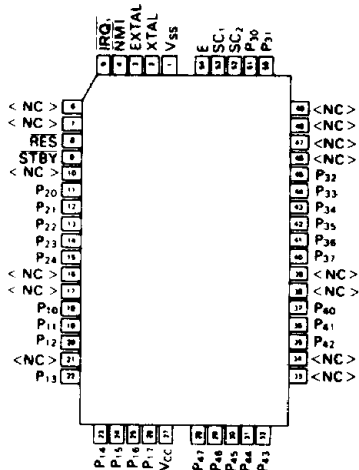
PIN ARRANGEMENT

- HD6301V1P, HD63A01V1P, HD63B01V1P



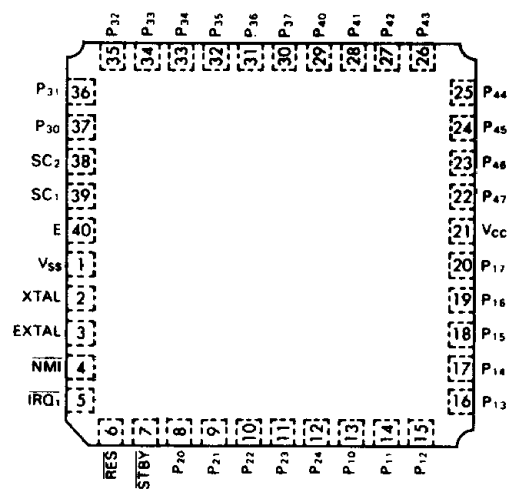
(Top View)

- HD6301V1F, HD63A01V1F, HD63B01V1F



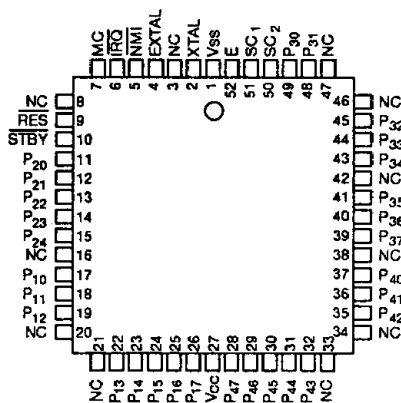
(Top View)

- HD6301V1CG, HD63A01V1CG, HD63B01V1CG



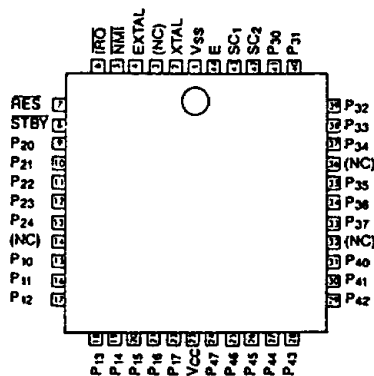
(Top View)

- HD6301V1CP, HD63A01V1CP, HD63B01V1CP



(Top View)

- HD6301V1L, HD63A01V1L, HD63B01V1L



(Top View)

HD6301V1, HD63A01V1, HD63B01V1

■ ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Value | Unit |
|-----------------------|-----------|---------------------|------|
| Supply Voltage | V_{CC} | -0.3 ~ +7.0 | V |
| Input Voltage | V_{in} | -0.3 ~ $V_{CC}+0.3$ | V |
| Operating Temperature | T_{opr} | 0 ~ +70 | °C |
| Storage Temperature | T_{stg} | -55 ~ +150 | °C |

(NOTE) This product has protection circuits in input terminal from high static electricity voltage and high electric field. But be careful not to apply overvoltage more than maximum ratings to these high input impedance protection circuits. To assure the normal operation, we recommend $V_{in}, V_{out} : V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

| Item | Symbol | Test Condition | min | typ | max | Unit | | |
|---|--|----------------|--|----------------------|--------------|--------------|---------|----|
| Input "High" Voltage | RES, STBY | V_{IH} | | $V_{CC}-0.5$ | - | $V_{CC}+0.3$ | V | |
| | EXTAL | | | $V_{CC} \times 0.7$ | - | | | |
| | Other Inputs | | | 2.0 | - | | | |
| Input "Low" Voltage | All Inputs | V_{IL} | | -0.3 | - | 0.8 | V | |
| Input Leakage Current | NMI, \overline{IRQ}_1 , RES, STBY | $ I_{in} $ | $V_{in} = 0.5 \sim V_{CC} - 0.5V$ | - | - | 1.0 | μA | |
| Three State (off-state) Leakage Current | $P_{10} \sim P_{17}, P_{20} \sim P_{24}, P_{30} \sim P_{37}, P_{40} \sim P_{47}, \overline{TS3}$ | $ I_{TSI} $ | $V_{in} = 0.5 \sim V_{CC} - 0.5V$ | - | - | 1.0 | μA | |
| Output "High" Voltage | All Outputs | V_{OH} | | $I_{OH} = -200\mu A$ | 2.4 | - | - | V |
| | | | | $I_{OH} = -10\mu A$ | $V_{CC}-0.7$ | - | - | V |
| Output "Low" Voltage | All Outputs | V_{OL} | $I_{OL} = 1.6mA$ | - | - | 0.55 | V | |
| Input Capacitance | All Inputs | C_{in} | $V_{in} = 0V, f = 1.0MHz, T_a = 25^\circ C$ | - | - | 12.5 | pF | |
| Standby Current | Non Operation | I_{CC} | $V_{IL}(\overline{STBY}) = 0 \sim 0.6V$ $V_{IH}(\overline{RES}) = V_{CC} - 0.5 \sim V_{CC} V$ $V_{IL}(\overline{RES}) = 0 \sim 0.6V$ | - | 2.0 | 15.0 | μA | |
| Current Dissipation* | | I_{CC} | | Operating (f=1MHz**) | - | 6.0 | 10.0 | mA |
| | | | | Sleeping (f=1MHz**) | - | 1.0 | 2.0 | |
| RAM Stand-By Voltage | | V_{RAM} | | 2.0 | - | - | V | |

* $V_{IH} \text{ min} = V_{CC} - 1.0V, V_{IL} \text{ max} = 0.8V$

** Current Dissipation of the operating or sleeping condition is proportional to the operating frequency. So the typ. or max. values about Current Dissipations at f = x MHz operation are decided according to the following formula;

typ. value (f = x MHz) = typ. value (f = 1MHz) x x
 max. value (f = x MHz) = max. value (f = 1MHz) x x
 (both the sleeping and operating)



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● AC CHARACTERISTICS ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)
BUS TIMING

| Item | Symbol | Test Condition | HD6301V1 | | | HD63A01V1 | | | HD63B01V1 | | | Unit | |
|--------------------------------------|-------------------------------------|----------------|----------|-----|-----|-----------|-----|-----|-----------|-----|-----|---------|----|
| | | | min | typ | max | min | typ | max | min | typ | max | | |
| Cycle Time | t_{cyc} | Fig. 1 | 1 | — | 10 | 0.666 | — | 10 | 0.5 | — | 10 | μs | |
| Address Strobe Pulse Width "High"* | PW_{ASH} | | 220 | — | — | 150 | — | — | 110 | — | — | ns | |
| Address Strobe Rise Time | t_{ASr} | | — | — | 20 | — | — | 20 | — | — | 20 | ns | |
| Address Strobe Fall Time | t_{ASf} | | — | — | 20 | — | — | 20 | — | — | 20 | ns | |
| Address Strobe Delay Time* | t_{ASD} | | 60 | — | — | 40 | — | — | 20 | — | — | ns | |
| Enable Rise Time | t_{Er} | | — | — | 20 | — | — | 20 | — | — | 20 | ns | |
| Enable Fall Time | t_{Ef} | | — | — | 20 | — | — | 20 | — | — | 20 | ns | |
| Enable Pulse Width "High" Level* | PW_{EH} | | 450 | — | — | 300 | — | — | 220 | — | — | ns | |
| Enable Pulse Width "Low" Level* | PW_{EL} | | 450 | — | — | 300 | — | — | 220 | — | — | ns | |
| Address Strobe to Enable Delay Time* | t_{ASED} | | 60 | — | — | 40 | — | — | 20 | — | — | ns | |
| Address Delay Time | t_{AD1} | | — | — | 250 | — | — | 190 | — | — | 160 | ns | |
| | t_{AD2} | | — | — | 250 | — | — | 190 | — | — | 160 | ns | |
| Address Delay Time for Latch* | t_{ADL} | | Fig. 2 | — | — | 250 | — | — | 190 | — | — | 160 | ns |
| Data Set-up Time | Write t_{DSW} | | Fig. 2 | 230 | — | — | 150 | — | — | 100 | — | — | ns |
| | Read t_{DSR} | | | 80 | — | — | 60 | — | — | 50 | — | — | ns |
| Data Hold Time | Read t_{HR} | | | 0 | — | — | 0 | — | — | 0 | — | — | ns |
| | Write t_{HW} | | | 20 | — | — | 20 | — | — | 20 | — | — | ns |
| Address Set-up Time for Latch* | t_{ASL} | | | 60 | — | — | 40 | — | — | 20 | — | — | ns |
| Address Hold Time for Latch | t_{AHL} | | | 30 | — | — | 20 | — | — | 20 | — | — | ns |
| Address Hold Time | t_{AH} | | | 20 | — | — | 20 | — | — | 20 | — | — | ns |
| $A_0 \sim A_7$ Set-up Time Before E* | t_{ASM} | 200 | | — | — | 110 | — | — | 60 | — | — | ns | |
| Peripheral Read Access Time | Non-Multiplexed Bus* (t_{ACCN}) | — | | — | 650 | — | — | 395 | — | — | 270 | ns | |
| | Multiplexed Bus* (t_{ACCM}) | — | | — | 650 | — | — | 395 | — | — | 270 | ns | |
| Oscillator stabilization Time | t_{RC} | Fig. 10 | | 20 | — | — | 20 | — | — | 20 | — | ms | |
| Processor Control Set-up Time | t_{PCS} | Fig. 11 | | 200 | — | — | 200 | — | — | 200 | — | ns | |

*These timings change in approximate proportion to t_{cyc} . The figures in this characteristics represent these when t_{cyc} is minimum (= in the highest speed operation).

PERIPHERAL PORT TIMING

| Item | Symbol | Test Condition | HD6301V1 | | | HD63A01V1 | | | HD63B01V1 | | | Unit |
|--|----------------------------|----------------|----------|-----|-----|-----------|-----|-----|-----------|-----|-----|------|
| | | | min | typ | max | min | typ | max | min | typ | max | |
| Peripheral Data Set-up Time | Port 1, 2, 3, 4 t_{PDSU} | Fig. 3 | 200 | — | — | 200 | — | — | 200 | — | — | ns |
| Peripheral Data Hold Time | Port 1, 2, 3, 4 t_{PDH} | Fig. 3 | 200 | — | — | 200 | — | — | 200 | — | — | ns |
| Delay Time, Enable Positive Transition to $\overline{OS3}$ Negative Transition | t_{OSD1} | Fig. 5 | — | — | 300 | — | — | 300 | — | — | 300 | ns |
| Delay Time, Enable Positive Transition to $\overline{OS3}$ Positive Transition | t_{OSD2} | Fig. 5 | — | — | 300 | — | — | 300 | — | — | 300 | ns |
| Delay Time, Enable Negative Transition to Peripheral Data Valid | Port 1, 2, 3, 4 t_{PWD} | Fig. 4 | — | — | 300 | — | — | 300 | — | — | 300 | ns |
| Input Strobe Pulse Width | t_{PWIS} | Fig. 6 | 200 | — | — | 200 | — | — | 200 | — | — | ns |
| Input Data Hold Time | Port 3 t_{IH} | Fig. 6 | 150 | — | — | 150 | — | — | 150 | — | — | ns |
| Input Data Setup Time | Port 3 t_{IS} | Fig. 6 | 0 | — | — | 0 | — | — | 0 | — | — | ns |

* Except P₂₁



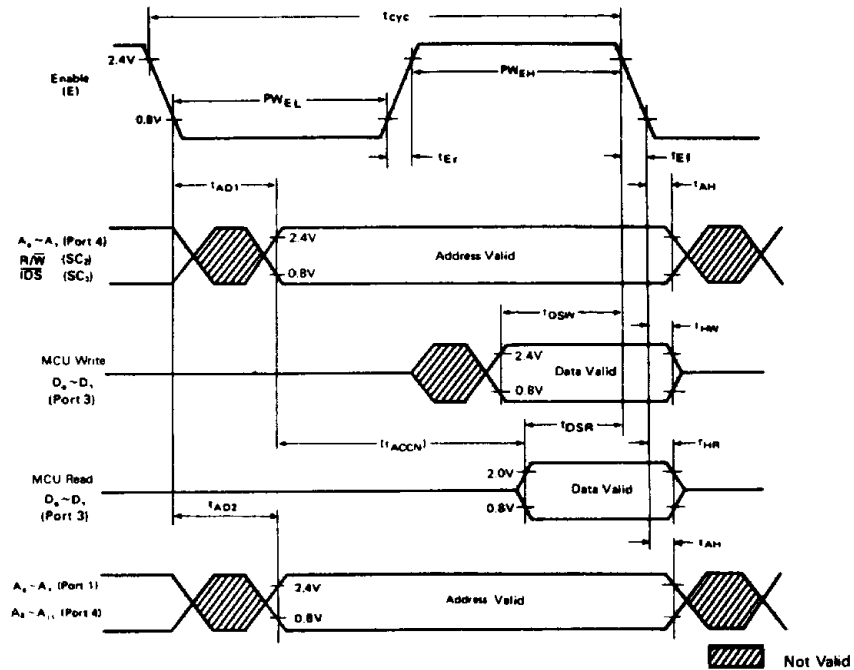
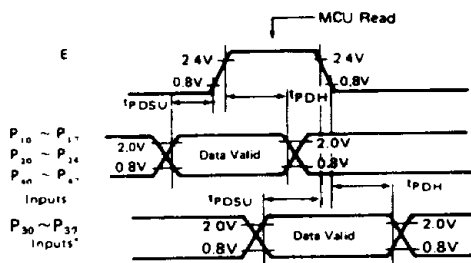
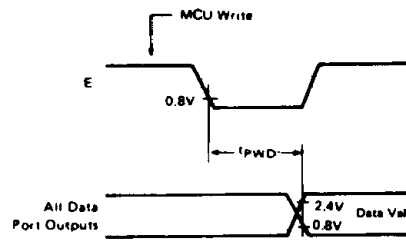


Figure 2 Expanded Non-Multiplexed Bus Timing



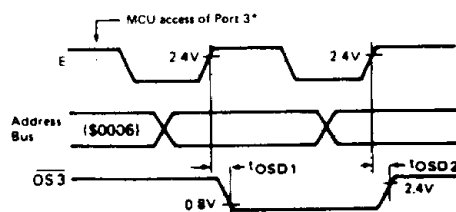
*Port 3 Non-Latched Operation

Figure 3 Port Data Set-up and Hold Times (MCU Read)



Note) Port 2: Except P₂₁

Figure 4 Port Data Delay Times (MCU Write)



*Access matches Output Strobe Select (OSS = 0, a read; OSS = 1, a write)

Figure 5 Port 3 Output Strobe Timing (Single Chip Mode)

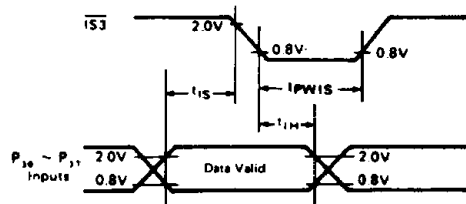


Figure 6 Port 3 Latch Timing (Single Chip Mode)

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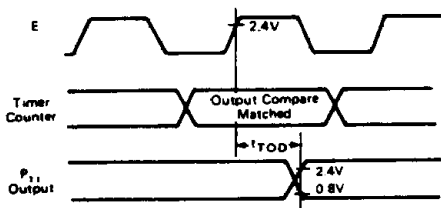


Figure 7 Timer Output Timing

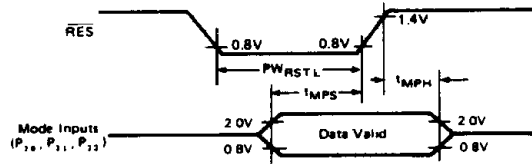


Figure 8 Mode Programming Timing

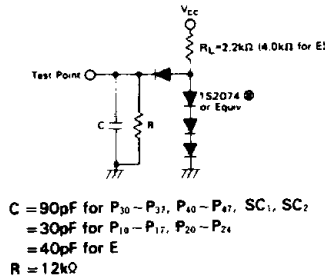


Figure 9 Bus Timing Test Loads (TTL Load)

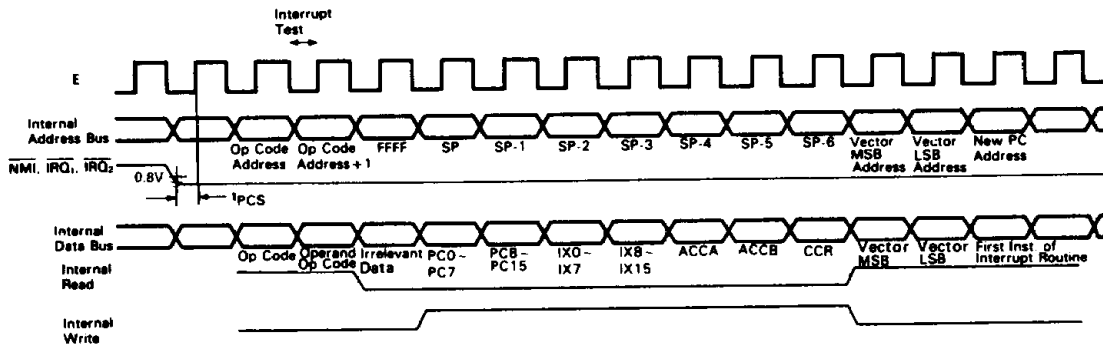


Figure 10 Interrupt Sequence

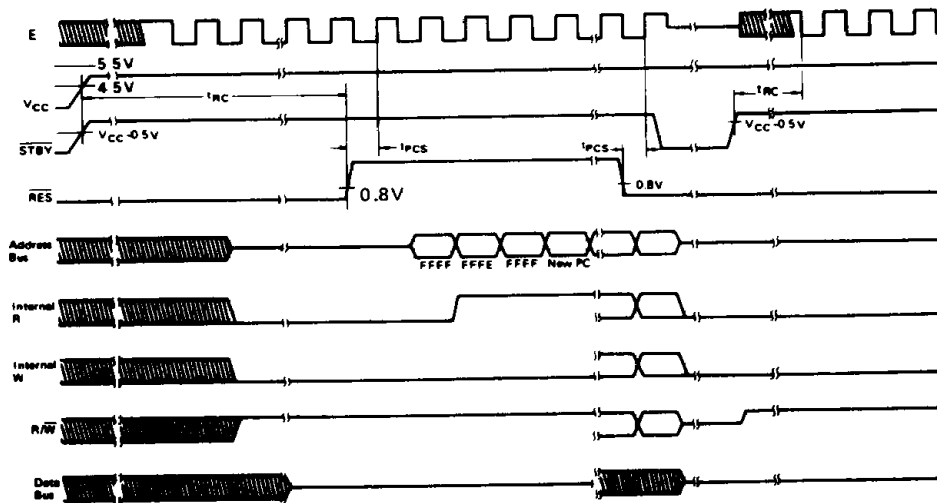


Figure 11 Reset Timing



FUNCTIONAL PIN DESCRIPTION

V_{CC}, V_{SS}

These two pins are used for power supply and GND. Recommended power supply voltage is 5V ±10%. 3 to 6V can be used for low speed operation (100 ~ 500 kHz).

XTAL, EXTAL

These two pins are connected with parallel resonant fundamental crystal, AT cut. For instance, in order to obtain the system clock 1MHz, a 4MHz resonant fundamental crystal is used because the divide-by-4 circuitry is included. An example of the crystal interface is shown in Fig. 12. EXTAL accepts an external clock input of duty 45% to 55% to drive, then internal clock is a quarter the frequency of an external clock. External driving frequency will be less than 4 times as maximum internal clock. For external clock, XTAL pin should be open.

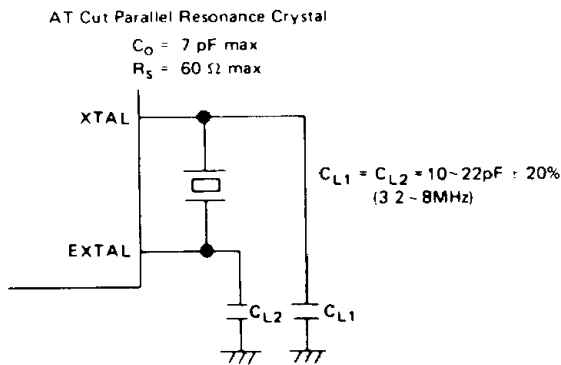


Figure 12 Crystal Interface

Standby (STBY)

This pin is used to place the MCU in the Standby mode. If this goes to "Low" level, the oscillation stops, the internal clock is tied to V_{SS} or V_{CC} and the MCU is reset. In order to retain information in RAM during standby mode, write "0" into RAM enable bit (RAME). RAME is bit 6 of the RAM Control Register at address \$0014. This disables the RAM, so the contents of RAM is guaranteed. For details of the standby mode, see the Standby section.

Reset (RES)

This input resets the MCU. RES must be held "Low" for at least 20ms when the power starts up. It should be noted that, before clock generator stabilize, the internal state and I/O ports are uncertain, because MCU can not be reset without clock. To reset the MCU during system operation, it must be held "Low" for at least 3 system clock cycles. From the third cycle, all address buses become "High-impedance" and it continues while RES is "Low". If RES goes to "High", CPU does the following.

- (1) I/O Port 2 bits, 2,1,0 are latched into bits PC2, PC1. PC0 of program control register.
- (2) The contents of the two Start Addresses, \$FFFE, \$FFFF are brought to the program counter, from which program starts (see Table 1).
- (3) The interrupt mask bit is set. In order to have the CPU

recognize the maskable interrupts $\overline{IRQ_1}$ and $\overline{IRQ_2}$, clear it before those are used.

Enable (E)

This output pin supplies system clock. Output is a single-phase, TTL compatible and 1/4 of the crystal oscillation frequency. It will drive two LS TTL load and 40pF.

Non maskable Interrupt (NMI)

When the falling edge of the input signal of this pin is recognized, NMI sequence starts. The current instruction is continued to complete, even if NMI signal is detected. Interrupt mask bit in Condition Code Register has no effect on NMI detection. In response to NMI interrupt, the information of Program Counter, Index Register, Accumulators, and Condition Code Register are stored on the stack. On completion of this sequence, vectoring address \$FFFC and \$FFFD are generated to load the contents to the program counter. Then the CPU branch to a non maskable interrupt service routine.

Interrupt Request ($\overline{IRQ_1}$)

This level sensitive input requests maskable interrupt sequence. When $\overline{IRQ_1}$ goes to "Low", the CPU waits until it completes the current instruction that is being executed. Then, if the interrupt mask bit in Condition Code Register is not set, CPU begins interrupt sequence; otherwise, interrupt request is neglected.

Once the sequence has started, the information of Program Counter, Index Register, Accumulators, Condition Code Register are stored on the stack. Then the CPU sets the interrupt mask bit so that no further maskable interrupts may be responded.

Table 1 Interrupt Vectoring memory map

| Highest Priority | Vector | | Interrupt |
|------------------|--------|------|----------------------------|
| | MSB | LSB | |
| | FFFE | FFFF | RES |
| | FFEE | FFEF | TRAP |
| | FFFC | FFFD | NMI |
| | FFFA | FFFB | Software Interrupt (SWI) |
| | FFF8 | FFF9 | $\overline{IRQ_1}$ (or IS) |
| | FFF6 | FFF7 | ICF (Timer Input Capture) |
| | FFF4 | FFF5 | OCF (Timer Output Compare) |
| | FFF2 | FFF3 | TOF (Timer Overflow) |
| Lowest Priority | FFF0 | FFF1 | SCI (IRDF + ORFE + TDRE) |

At the end of the cycle, the CPU generates 16 bit vectoring addresses indicating memory addresses \$FFF8 and \$FFF9, and load the contents to the Program Counter, then branch to an interrupt service routine.

The Internal Interrupt will generate signal ($\overline{IRQ_2}$) which is quite the same as $\overline{IRQ_1}$ except that it will use the vector address \$FFF0 to \$FFF7.

When $\overline{IRQ_1}$ and $\overline{IRQ_2}$ are generated at the same time, the former precede the latter. Interrupt Mask Bit in the condition code register, if being set, will keep the both interrupts off.

$\overline{IRQ_1}$ has no internal latch. Therefore, if $\overline{IRQ_1}$ is removed during suspension, that $\overline{IRQ_1}$ is ignored.

On occurrence of Address error or Op-code error, TRAP interrupt is invoked. This interrupt has priority next to RES. Regardless of the Interrupt Mask Bit condition, the CPU will

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start an interrupt sequence. The vector for this interrupt will be \$FFEE, \$FFEF.

The following pins are available only in single chip mode.

- **Input Strobe ($\overline{IS3}$) (SC₁)**

This signal controls $\overline{IS3}$ interrupt and the latch of Port 3. When the falling edge of this signal is detected, the flag of Port 3 Control Status Register is set.

For detailed explanation of Port 3 Control Status Register, see the I/O PORT 3 CONTROL STATUS REGISTER section.

- **Output Strobe ($\overline{OS3}$) (SC₂)**

This signal is used to send a strobe to an external device, indicating effective data is on the I/O pins. The timing chart for Output Strobe are shown in Figure 5.

The following pins are available for Expanded Modes.

- **Read/Write (R/\overline{W}) (SC₂)**

This output signal indicates peripheral and memory devices whether CPU is in Read ("High"), or in Write ("Low"). The normal stand-by state is Read ("High"). Its output will drive one TTL load and 90pF.

- **I/O Strobe (\overline{IOS}) (SC₁)**

In expanded non multiplexed mode 5 of operation, \overline{IOS} goes to "Low" only when A₉ through A₁₅ are "0" and A₈ is "1". This allows external access up to 256 addresses from \$0100 to \$01FF in memory. The timing chart is shown in Figure 2.

- **Address Strobe (AS) (SC₁)**

In the expanded multiplexed mode, address strobe signal appears at this pin. It is used to latch the lower 8 bits addresses multiplexed with data at Port 3. The 8-bit latch is controlled by address strobe as shown in Figure 18. Thereby, I/O Port 3 can become data bus during E pulse. The timing chart of this signal is shown in Figure 1.

Address Strobe (AS) is sent out even if the internal address area is accessed.

- **PORTS**

There are four I/O Ports on HD6301V1 MCU (three 8-bit ports and one 5-bit port). 2 control pins are connected to one of the 8-bit port. Each port has an independent write-only data direction register to program individual I/O pins for input or output.*

When the bit of associated Data Direction Register is "1", I/O pin is programmed for output, if "0", then programmed for an input.

There are four ports: Port 1, Port 2, Port 3, and Port 4. Addresses of each port and associated Data Direction Registers are shown in Table 2.

* Only one exception is bit 1 of Port 2 which becomes either a data input or a timer output. It cannot be used as an output port.

RES does not affect I/O port Data Register. Therefore, just after RES, Data Register is uncertain. Data Direction Registers are reset.

Table 2 Port and Data Direction Register Addresses

| Ports | Port Address | Data Direction Register Address |
|------------|--------------|---------------------------------|
| I/O Port 1 | \$0002 | \$0000 |
| I/O Port 2 | \$0003 | \$0001 |
| I/O Port 3 | \$0006 | \$0004 |
| I/O Port 4 | \$0007 | \$0005 |

- **I/O Port 1**

This is an 8-bit port, each bit being defined individually as input or outputs by associated Data Direction Register. The 8-bit output buffers have three-state capability, maintaining in high impedance state when they are used for input. In order to be read accurately, the voltage on the input lines must be more than 2.0V for logic "1" and less than 0.8V for logic "0".

These are TTL compatible. After the MCU has been reset, all I/O lines of Port 1 are configured as inputs in all modes except mode 1. In all modes except Mode 1, Port 1 is always parallel I/O. In mode 1, Port 1 will be output line for lower order address lines (A₀ to A₇).

- **I/O Port 2**

This port has five lines, whose I/O direction depends on its data direction register. The 5-bit output buffers have three-state capability, going high impedance state when used as inputs. In order to be read accurately, the voltage on the input lines must be more than 2.0V for logic "1" and less than 0.8V for logic "0". After the MCU has been reset, I/O lines are configured as inputs. These pins of Port 2 (pins P₂₀, P₂₁, P₂₂ of the chip) are used to program the mode of operation during reset. The values of these three pins during reset are latched into the upper 3 bits (bit 7, 6 and 5) of Port 2 Data Register, which is explained in the MODE SELECTION section.

In all modes, Port 2 can be configured as I/O lines. This port also provides access to the Serial I/O and the Timer. However, note that bit 1 (P₂₁) is the only pin restricted to data input or Timer output.

- **I/O Port 3**

This is an 8-bit port which can be configured as I/O lines, a data bus, or an address bus multiplexed with data bus. Its function depends on hardware operation mode programmed by the user using 3 bits of Port 2 during Reset. Port 3 as a data bus is bi-directional. For an input from peripherals, regular TTL level must be supplied, that is greater than 2.0V for a logic "1" and less than 0.8V for a logic "0". This TTL compatible three-state buffer can drive one TTL load and 90pF capacitance. In the expanded Modes, data direction register will be inhibited after Reset and data direction will depend on the state of the R/W line. Function of Port 3 is shown below.

- **Single Chip Mode (Mode 7)**

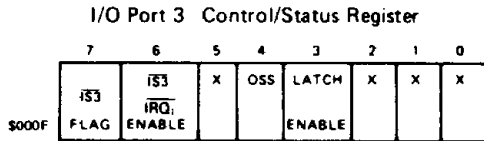
Parallel Inputs/Outputs as programmed by its corresponding Data Direction Register.

There are two control lines associated with this port in this mode, an input strobe ($\overline{IS3}$) and an output strobe ($\overline{OS3}$), both being used for handshaking. They are controlled by I/O Port 3 Control/Status Register. Function of these two control lines of Port 3 are summarized as follows:

- (1) Port 3 input data can be latched using $\overline{IS3}$ (SC₁) as a input strobe signal.
- (2) $\overline{OS3}$ can be generated by CPU read or write to Port 3's data register.
- (3) $\overline{IRQ1}$ interrupt can be generated by an $\overline{IS3}$ falling edge.

Port 3 strobe and latch timing is shown in Figs. 5 and 6 respectively.

I/O Port 3 Control/Status Register is explained as follows:



Bit 0 Not used.

Bit 1 Not used.

Bit 2 Not used.

Bit 3 LATCH ENABLE.

Bit 3 is used to control the input latch of Port 3. If the bit is set at "1", the input data on Port 3 is latched by the falling edge of $\overline{IS3}$. The latch is released by the \overline{MCU} read to Port 3; now new data can be latched again by $\overline{IS3}$ falling edge. Bit 3 is cleared by a reset. If this bit is "0", $\overline{IS3}$ does not affect I/O Port 3 latch operation.

Bit 4 OSS (Output Strobe Select)

This bit identifies the cause of output strobe generation: a write operation or read operation to I/O Port 3. When the bit is cleared, the strobe will be generated by a read operation to Port 3. When the bit is not cleared, the strobe will be generated by a write operation. Bit 4 is cleared by a reset.

Bit 5 Not used.

Bit 6 $\overline{IS3}$ $\overline{IRO_1}$ ENABLE.

If this bit is set, $\overline{IRO_1}$ interrupt by $\overline{IS3}$ Flag is enabled. Otherwise the interrupt is disabled. The bit is cleared by a reset.

Bit 7 $\overline{IS3}$ FLAG.

Bit 7 is a read-only bit which is set by the falling edge of $\overline{IS3}$ (SC_1). It is cleared by a read of the Control/Status Register followed by a read/write of I/O Port 3. The bit is cleared by reset.

Expanded Non Multiplexed Mode (mode 1,5)

In this mode, Port 3 becomes data bus. ($D_0 \sim D_7$)

Expanded Multiplexed Mode (mode 0, 2, 4, 6)

Port 3 becomes both the data bus ($D_0 \sim D_7$) and lower bits of the address bus ($A_0 \sim A_7$). An address strobe output is "High" while the address is on the port.

● **I/O Port 4**

This is an 8-bit port that becomes either I/O or address outputs depending on the selected operation mode. In order to be read accurately, the voltage at the input lines must be greater than 2.0V for a logic "1", and less than 0.8V for a logic "0". For outputs, each line is TTL compatible and can drive one TTL load and 90pF. Function of Port 4 for each mode is explained below.

Single Chip Mode (Mode 7): Parallel Inputs/Outputs as programmed by its associated data direction register.

Expanded Non Multiplexed Mode (Mode 5): In this mode, Port 4 becomes the lower address lines (A_0 to A_7) by writing "1"s on the data direction register. After reset, this port becomes inputs. In order to use these pins as addresses, they should be programmed as outputs.

When all of the eight bits are not required as addresses, the remaining lines can be used as I/O lines (Inputs only).

Expanded Non Multiplexed Mode (Mode 1): In this mode, Port 4 becomes output for upper order address lines (A_8 to A_{15}) regardless of the value of the direction register.

Expanded Multiplexed Mode (Mode 6): In this mode, Port 4 becomes the upper address lines (A_8 to A_{15}). After reset, this

port becomes inputs. In order to use these pins as addresses, they should be programmed as outputs. When all of the eight bits are not required, the remaining lines can be used as I/O lines (input only).

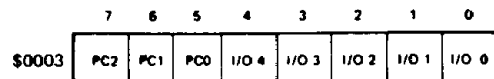
Expanded Multiplexed Mode (Mode 0, 2, 4): In this mode, Port 4 becomes output for upper order address lines (A_8 to A_{15}) regardless of the value of data direction register.

The relation between each mode and I/O Port 1 to 4 is summarized in Table 3.

■ MODE SELECTION

The operation mode after the reset must be determined by the user wiring the P_{20} , P_{21} and P_{22} pins externally. These three pins are lower order bits; I/O 0, I/O 1, I/O 2 of Port 2. They are latched into the control bits PC0, PC1, PC2 of I/O Port 2 register when reset goes "High". I/O Port 2 Register is shown below.

Port 2 DATA REGISTER



An example of external hardware used for Mode Selection is shown in Fig. 13. The HD14053B is used to separate the peripheral device from the MCU during reset. It is necessary if the data may conflict between peripheral device and Mode generation circuit.

No mode can be changed through software because the bits 5, 6, and 7 of Port 2 Data Register are read-only. The mode selection of the HD6301V1 is shown in Table 4.

The HD6301V1 operates in three basic modes: (1) Single Chip Mode; (2) Expanded Multiplexed Mode (compatible with the HMCS6800 peripheral family), (3) Expanded Non Multiplexed Mode (compatible with HMCS6800 peripheral family).

● **Single Chip Mode (Mode 7)**

In the Single Chip Mode, all ports will become I/O. This is shown in Figure 15. In this mode, SC_1 , SC_2 pins are configured for control lines of Port 3 and can be used as input strobe ($\overline{IS3}$) and output strobe ($\overline{OS3}$) for data handshaking.

● **Expanded Multiplexed Mode (Mode 0, 2, 4, 6)**

In this mode, Port 4 is configured for I/O (inputs only) or address lines. The data bus and the lower order address bus are multiplexed in Port 3 and can be separated by the Address Strobe.

Port 2 is configured for 5 parallel I/O or Serial I/O, or Timer, or any combination thereof. Port 1 is configured for 8 parallel I/O. In this mode, HD6301V1 is expandable up to 65k words (See Fig. 16).

● **Expanded Non Multiplexed Mode (Mode 1, 5)**

In this mode, the HD6301V1 can directly address HMCS6800 peripherals with no address latch. In mode 5, Port 3 becomes a data bus. Port 4 becomes A_0 to A_7 address bus or partial address bus and I/O (inputs only). Port 2 is configured for a parallel I/O, Serial I/O, Timer or any combination thereof.

Port 1 is configured as a parallel I/O only.

In this mode, HD6301V1 is expandable to 256 locations.

In mode 1, Port 3 becomes a data bus and Port 1 becomes A_0 to A_7 address bus, and Port 4 becomes A_8 to A_{15} address bus.

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In this mode, the HD6301V1 is expandable to 65k bytes with no address latch. (See Fig. 17).

• **Lower Order Address Bus Latch**

Because the data bus is multiplexed with the lower order

address bus in Port 3 in the expanded multiplexed mode, address bits must be latched. It requires the 74LS373 Transparent octal D-type to latch the LSB. Latch connection of the HD6301V1 is shown in Figure 18.

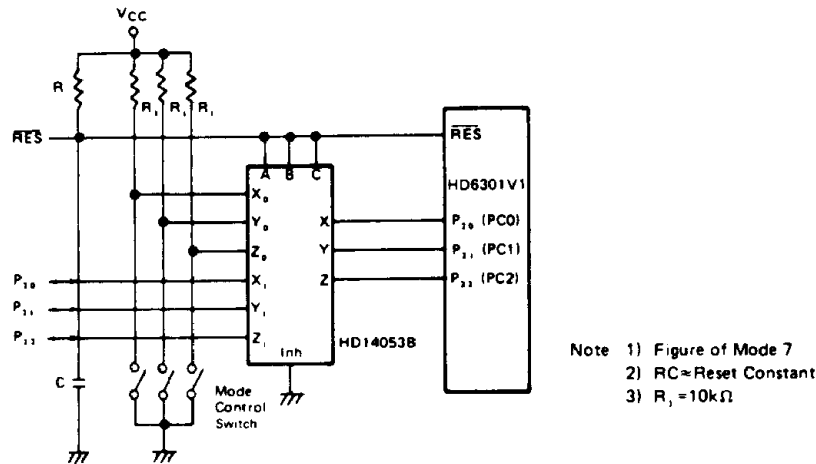
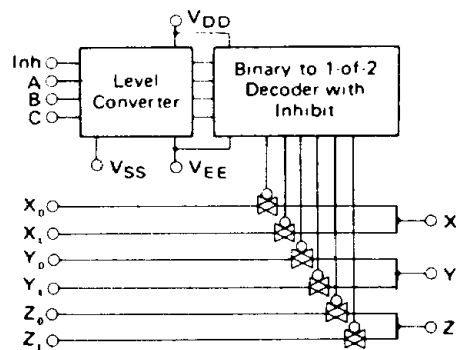


Figure 13 Recommended Circuit for Mode Selection



Truth Table

| Control Input | | | On Switch | | | |
|---------------|--------|---|-----------|----------------|----------------|----------------|
| Inhibit | Select | | | HD14053B | | |
| | C | B | A | Z | Y | X |
| 0 | 0 | 0 | 0 | Z ₀ | Y ₀ | X ₀ |
| 0 | 0 | 0 | 1 | Z ₀ | Y ₀ | X ₁ |
| 0 | 0 | 1 | 0 | Z ₀ | Y ₁ | X ₀ |
| 0 | 0 | 1 | 1 | Z ₀ | Y ₁ | X ₁ |
| 0 | 1 | 0 | 0 | Z ₁ | Y ₀ | X ₀ |
| 0 | 1 | 0 | 1 | Z ₁ | Y ₀ | X ₁ |
| 0 | 1 | 1 | 0 | Z ₁ | Y ₁ | X ₀ |
| 0 | 1 | 1 | 1 | Z ₁ | Y ₁ | X ₁ |
| 1 | X | X | X | | | |

Figure 14 HD14053B Multiplexers/De-Multiplexers

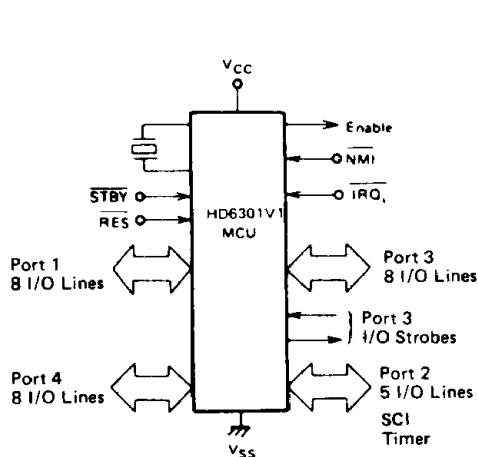


Figure 15 HD6301V1 MCU Single-Chip Mode

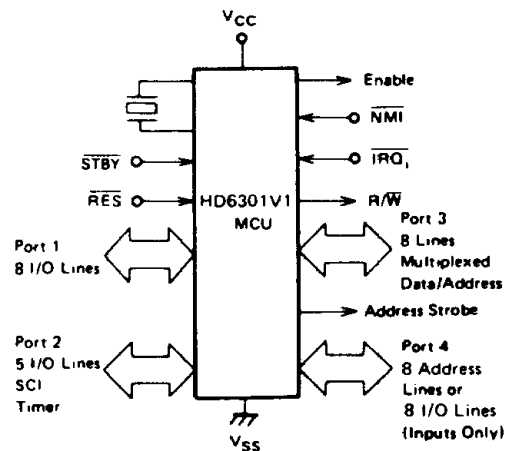


Figure 16 HD6301V1 MCU Expanded Multiplexed Mode



HD6301V1, HD63A01V1, HD63B01V1

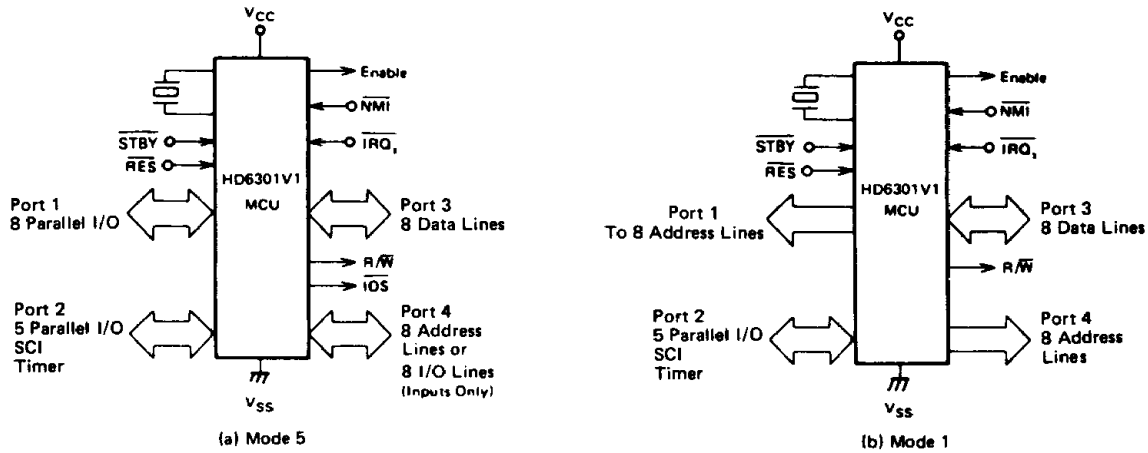


Figure 17 HD6301V1 MCU Expanded Non Multiplexed Mode

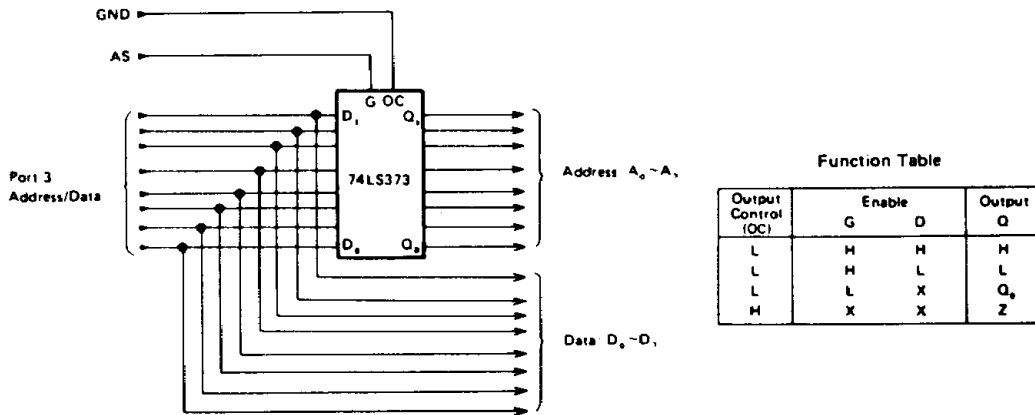


Figure 18 Latch Connection

● **Summary of Mode and MCU Signal**

This section gives a description of the MCU signals for the various modes. SC₁ and SC₂ are signals which vary with the mode.

Table 3 Feature of each mode and lines

| MODE | PORT 1 Eight Lines | PORT 2 Five Lines | PORT 3 Eight Lines | PORT 4 Eight Lines | SC ₁ | SC ₂ |
|-----------------------------------|---|----------------------|---|---|-----------------|-----------------|
| SINGLE CHIP (Mode 7) | I/O | I/O | I/O | I/O | IS3 (I) | OS3 (O) |
| EXPANDED MUX (Mode 0, 2, 4, 6) | I/O | I/O | ADDRESS BUS (A ₀ - A ₇) DATA BUS (D ₀ - D ₇) | ADDRESS BUS* (A ₈ - A ₁₅) | AS(O) | R/W(O) |
| EXPANDED (Mode 5) | I/O | I/O | DATA BUS (D ₀ - D ₇) | ADDRESS BUS* (A ₀ - A ₇) | I/O(S)(O) | R/W(O) |
| NON-MUX (Mode 1) | ADDRESS BUS (A ₀ - A ₇) | I/O | DATA BUS (D ₀ - D ₇) | ADDRESS BUS (A ₈ - A ₁₅) | Not Used | R/W(O) |

*These lines can be substituted for I/O (Input Only) (except Mode 0, 2, 4)

| | | |
|------------------|---------------------|---------------------|
| I = Input | IS3 = Input Strobe | SC = Strobe Control |
| O = Output | OS3 = Output Strobe | AS = Address Strobe |
| R/W = Read/Write | I/O S = I/O Select | |



Table 4 Mode Selection Summary

| Mode | P ₁₃ (PC2) | P ₁₁ (PC1) | P ₁₀ (PC0) | ROM | RAM | Interrupt Vectors | Bus Mode | Operating Mode |
|------|--------------------------|--------------------------|--------------------------|------------------|------------------|----------------------|---------------------|--------------------------------|
| 7 | H | H | H | I | I | I | I | Single Chip |
| 6 | H | H | L | I | I | I | MUX ⁽⁴⁾ | Multiplexed/Partial Decode |
| 5 | H | L | H | I | I | I | NMUX ⁽⁴⁾ | Non-Multiplexed/Partial Decode |
| 4 | H | L | L | E ⁽²⁾ | I ⁽¹⁾ | E | MUX | Multiplexed/RAM |
| 3 | L | H | H | — | — | — | — | Not Used |
| 2 | L | H | L | E ⁽²⁾ | I ⁽¹⁾ | E | MUX | Multiplexed/RAM |
| 1 | L | L | H | E ⁽²⁾ | I | E | NMUX | Non-Multiplexed |
| 0 | L | L | L | I | I | I ⁽³⁾ | MUX | Multiplexed Test |

LEGEND :

I — Internal
 E — External
 MUX — Multiplexed
 NMUX — Non-Multiplexed
 L — Logic "0"
 H — Logic "1"

(NOTES)

1) Internal RAM is addressed at \$0080.
 2) Internal ROM is disabled.
 3) Reset vector is external for 3 or 4 cycles after RES goes "high".
 4) Idle lines of Port 4 address outputs can be assigned to Input Port.

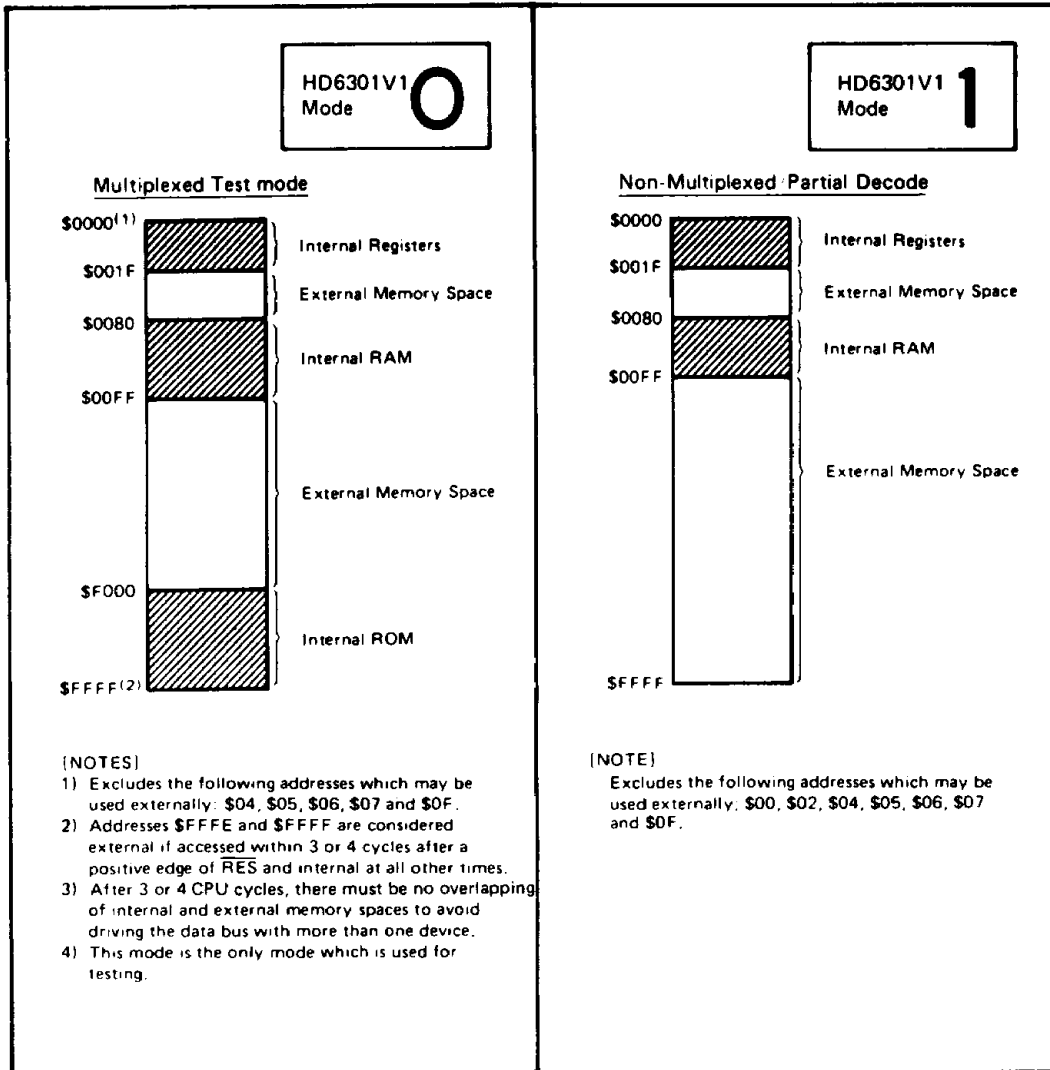
■ **Memory Map**

The MCU can provide up to 65k byte address space depending on the operating mode. Fig. 19 shows a memory map for each operating mode. The first 32 locations of each map are for the MCU's internal register only, as shown in Table 5.

Table 5 Internal Register Area

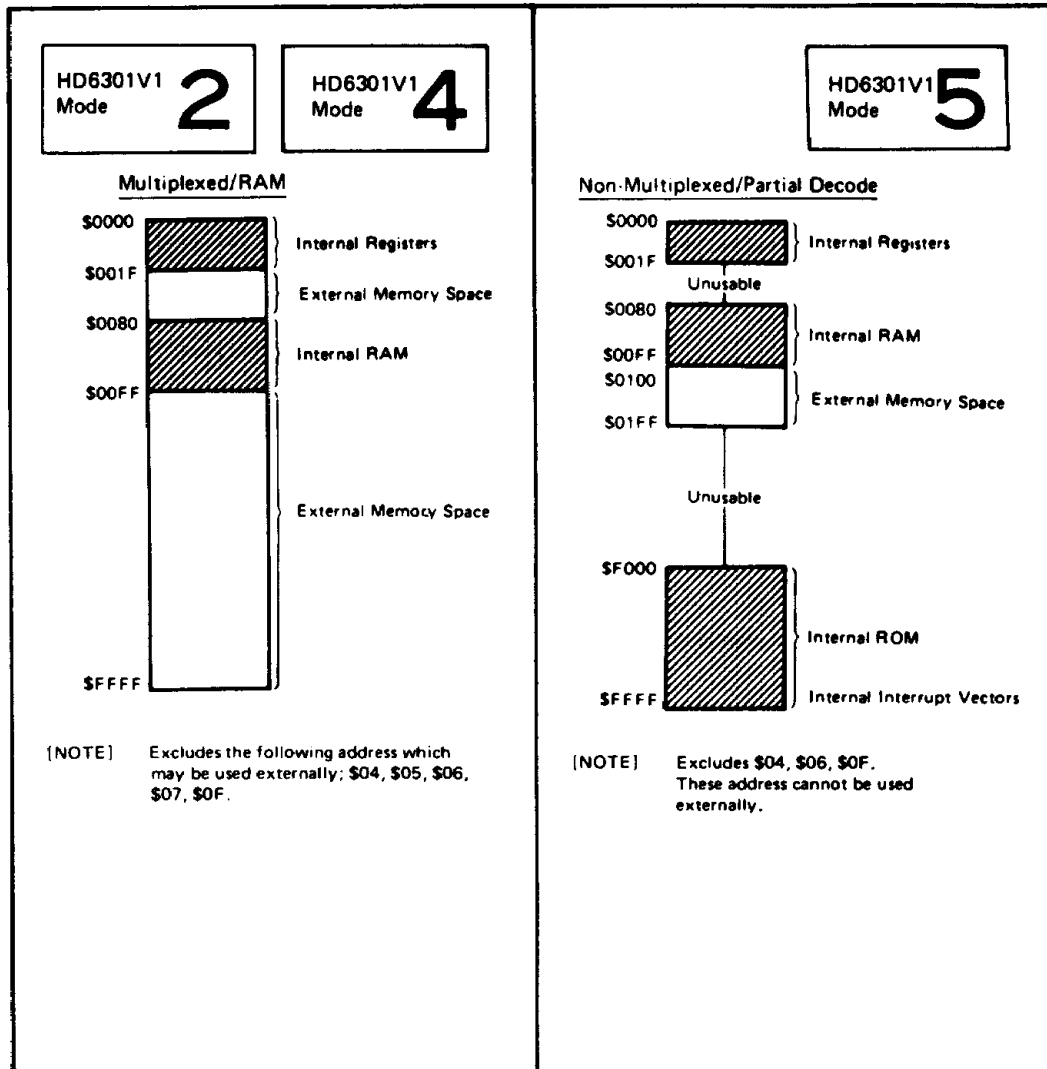
| Register | Address |
|--|---------|
| Port 1 Data Direction Register **** | 00* |
| Port 2 Data Direction Register **** | 01 |
| Port 1 Data Register | 02* |
| Port 2 Data Register | 03 |
| Port 3 Data Direction Register **** | 04** |
| Port 4 Data Direction Register **** | 05*** |
| Port 3 Data Register | 06** |
| Port 4 Data Register | 07*** |
| Timer Control and Status Register | 08 |
| Counter (High Byte) | 09 |
| Counter (Low Byte) | 0A |
| Output Compare Register (High Byte) | 0B |
| Output Compare Register (Low Byte) | 0C |
| Input Capture Register (High Byte) | 0D |
| Input Capture Register (Low Byte) | 0E |
| Port 3 Control and Status Register | 0F** |
| Rate and Mode Control Register | 10 |
| Transmit/Receive Control and Status Register | 11 |
| Receive Data Register | 12 |
| Transmit Data Register | 13 |
| RAM Control Register | 14 |
| Reserved | 15-1F |

- * External address in Mode 1
- ** External address in Modes 0, 1, 2, 4, 6; cannot be accessed in Mode 5
- *** External address in Modes 0, 1, 2, 4
- **** 1 = Output, 0 = Input



(to be continued)

Figure 19 HD6301V1 Memory Maps



(to be continued)

Figure 19 HD6301V1 Memory Maps

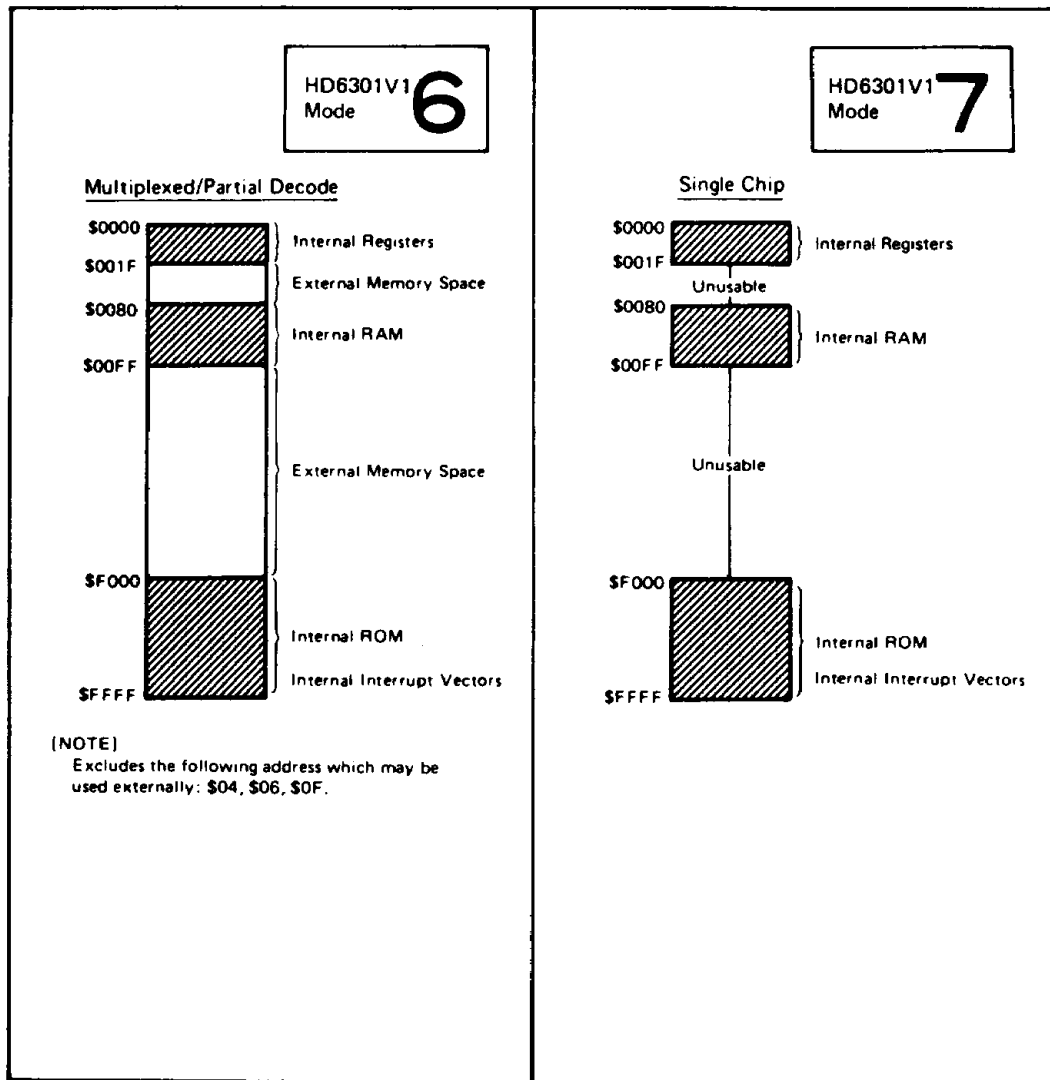


Figure 19 HD6301V1 Memory Maps

HD6301V1, HD63A01V1, HD63B01V1

PROGRAMMABLE TIMER

The HD6301V1 contains 16-bit programmable timer which may be used to make measurement of input waveform. In addition to that it can generate an output waveform by itself. For both input and output waveform, the pulse width may vary from a few microseconds to several seconds.

The timer hardware consists of

- an 8-bit control and status register
- a 16-bit free running counter
- a 16-bit output compare register, and
- a 16-bit input capture register

A block diagram of the timer is shown in Figure 20.

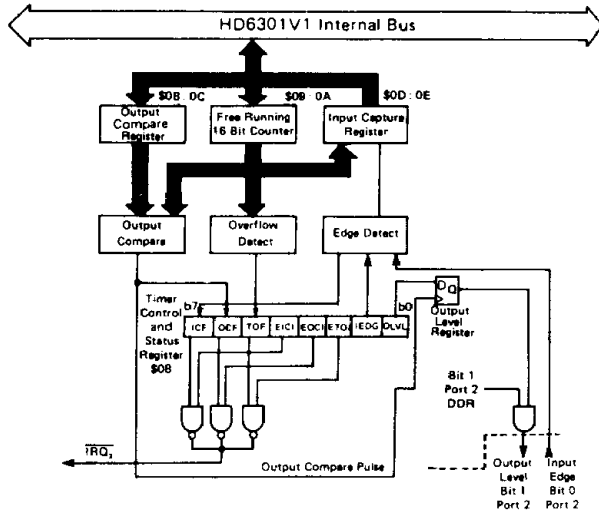


Figure 20 Programmable Timer Block Diagram

Free Running Counter (\$0009: \$000A)

The key element in the programmable timer is a 16-bit free running counter, that is driven by an E (Enable) clock to increment its values. The counter value will be read out by the CPU software at any time with no effects on the counter. Reset will clear the counter.

When the upper byte of this counter is read, the lower byte is stored in temporary latch. The data is fetched from this latch by the subsequent read of the lower byte. Thus consistent double byte data can be read from the counter.

When the CPU writes arbitrary data to the upper byte (\$09), the value of \$FFF8 is being pre-set to the counter (\$09, \$0A) regardless of the write data value. Then the CPU writes arbitrary data to the lower byte (\$0A), the data is set to the "Low" byte of the counter, at the same time, the data precedingly written in the upper byte (\$09) is set to "High" byte of the counter.

When the data is written to this counter, a double byte store instruction (ex. STD) must be used. If only the upper byte of counter is written, the counter is set to \$FFF8.

The counter value written to the counter using the double byte store instruction is shown in Figure 21.

To write to the counter may disturb serial operations, so it should be inhibited during using the SCI in internal clock mode.

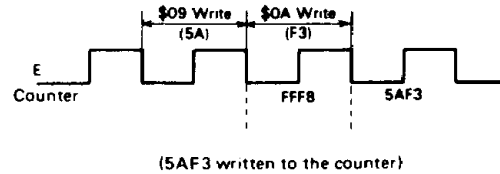


Figure 21 Counter Write Timing

Output Compare Register (\$000B: \$000C)

This is a 16-bit read/write register which is used to control an output waveform. The contents of this register are constantly being compared with current value of the free running counter.

When the contents match with the value of the free running counter, a flag (OCF) in the timer control/status register (TCSR) is set and the current value of an output level Bit (OLVL) in the TCSR is transferred to Port 2 bit 1. When bit 1 of the Port 2 data direction register is "1" (output), the OLVL value will appear on the bit 1 of Port 2. Then, the value of Output Compare Register and Output level bit may be changed for the next compare.

The output compare register is set to \$FFFF during reset.

The compare function is inhibited at the cycle of writing to the high byte of the output compare register and at the cycle just after that to ensure valid compare. It is also inhibited in same manner at writing to the free running counter.

In order to write a data to Output Compare Register, a double byte store instruction (ex. STD) must be used.

Input Capture Register (\$000D: \$000E)

The input capture register is a 16-bit read-only register used to hold the current value of free running counter when the proper transition of an external input signal occurs.

The input transition change required to trigger the counter transfer is controlled by the input edge bit (IEDG).

To allow the external input signal to go in the edge detect unit, the bit of the Data Direction Register corresponding to bit 0 of Port 2 must have been cleared (to zero).

To insure input capture in all cases, the width of an input pulse requires at least 2 Enable cycles.

Timer Control/Status Register (TCSR) (\$0008)

This is an 8-bit register. All 8 bits are readable and the lower 5-bit may be written. The upper 3 bits are read-only, indicating the timer status information as is shown below.

- (1) A proper transition has been detected on the input pin (ICF).
- (2) A match has been found between the value in the free running counter and the output compare register (OCF).
- (3) When counting up to \$0000 (TOF).

Each flag has an individual enable bit in TCSR which determines whether or not an interrupt request may occur (IRQ₂). If the I-bit in Condition Code Register has been cleared, a priority vectored address occurs corresponding to each flag. A description of each bit is as follows.

| Timer Control / Status Register | | | | | | | |
|---------------------------------|-----|-----|------|------|------|------|------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| ICF | OCF | TOF | EICI | EOCI | ETOI | IEDG | OLVL |

\$0008

Bit 0 OLVL (Output Level); When a match is found in the value between the counter and the output com-

pare register, this bit is transferred to the Port 2 bit 1. If the DDR corresponding to Port 2 bit 1 is set "1", the value will appear on the output pin of Port 2 bit 1.

- Bit 1 IEDG (Input Edge):** This bit control which transition of an input of Port 2 bit 0 will trigger the data transfer from the counter to the input capture register. The DDR corresponding to Port 2 bit 0 must be cleared in advance of using this function. When IEDG = 0, trigger takes place on a negative edge ("High" to "Low" transition). When IEDG = 1, trigger takes place on a positive edge ("Low" to "High" transition).
- Bit 2 ETOI (Enable Timer Overflow Interrupt):** When set, this bit enables TOF interrupt to generate the interrupt request (\overline{IRQ}_2). When cleared, the interrupt is inhibited.
- Bit 3 EOCI (Enable Output Compare Interrupt):** When set, this bit enables OCF interrupt to generate the interrupt request (\overline{IRQ}_2). When cleared, the interrupt is inhibited.
- Bit 4 EICI (Enable Input Capture Interrupt):** When set, this bit enables ICF interrupt to generate the interrupt request (\overline{IRQ}_2). When cleared, the interrupt is inhibited.
- Bit 5 TOF (Timer Over Flow Flag):** This read-only bit is set at the transition of \$FFFF to \$0000 of the counter. It is cleared by CPU read of TCSR (with TOF set) followed by an CPU read of the counter (\$0009).
- Bit 6 OCF (Output Compare Flag):** This read-only bit is set when a match is found in the value between the output compare register and the counter. It is cleared by a read of TCSR (with OCF set) followed by an CPU write to the output compare register (\$000B or \$000C).
- Bit 7 ICF (Input Capture Flag):** The read-only bit is set by a proper transition on the input, and is cleared by a read of TCSR (with ICF set) followed by an CPU read of Input Capture Register (\$000D).

Reset will clear each bit of Timer Control and Status Register.

■ SERIAL COMMUNICATION INTERFACE

The HD6301V1 contains a full-duplex asynchronous Serial Communication Interface (SCI). SCI may select the several kinds of the data rate. It consists of a transmitter and a receiver which operate independently but with the same data format and the same data rate. Both the transmitter and receiver communicate with the CPU via the data bus and with the outside world through Port 2 bit 2, 3 and 4. Description of hardware, software and register is as follows.

● Wake-Up Feature

In typical multiprocessor applications the software protocol will usually have the designated address at the initial byte of the message. The purpose of Wake-Up feature is to have the non-selected MCU neglect the remainder of the message. Thus the non-selected MCU can inhibit the all further interrupt process until the next message begins.

Wake-Up feature is re-enabled by a ten consecutive "1"s which indicates an idle transmit line. Therefore software protocol must put an idle period between the messages and must prevent it within the message.

With this hardware feature, the non-selected MCU is re-enabled or ("waked-up") by the next message.

● Programmable Options

- The HD6301V1 has the following programmable features.
- data format; standard mark/space (NRZ)
 - clock source; external or internal
 - baud rate; one of 4 rates per given E clock frequency or 1/8 of external clock
 - wake-up feature; enabled or disabled
 - interrupt requests; enabled or masked individually for transmitter and receiver
 - clock output; internal clock enabled or disabled to Port 2 bit 2
 - Port 2 (bits 3, 4); dedicated or not dedicated to serial I/O individually

● Serial Communication Hardware

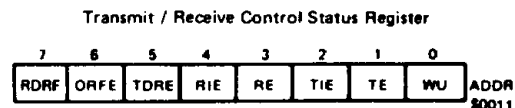
The serial communications hardware is controlled by 4 registers as shown in Figure 22. The registers include:

- an 8-bit control/status register
- a 4-bit rate/mode control register (write-only)
- an 8-bit read-only receive data register
- an 8-bit write-only transmit data register

Besides these 4 registers, Serial I/O utilizes Port 2 bit 3 (input) and bit 4 (output). Port 2 bit 2 can be used when an option is selected for the internal-clock-out or the external-clock-in.

● Transmit/Receive Control Status Register (TRCSR)

TRCS Register consists of 8 bits which all may be read while only bits 0 to 4 may be written. The register is initialized to \$20 on RES. The bits of the TRCS register are explained below.



Bit 0 WU (Wake Up); Set by software and cleared by hardware on receipt of ten consecutive "1"s. While this bit is "1", RDRF and ORFE flags are not set even if data are received or errors are detected. Therefore received data are ignored. It should be noted that RE flag must have already been set in advance of WU flag's set.

Bit 1 TE (Transmit Enable); This bit enables transmitter. When this bit is set, bit 4 of Port 2 DDR is also forced to be set. It remains set even if TE is cleared. Preamble of ten consecutive "1"s is transmitted just after this bit is set, and then transmitter becomes ready to send data.

If this bit is cleared, the transmitter is disabled and serial I/O affects nothing on Port 2 bit 4.

Bit 2 TIE (Transmit Interrupt Enable); When this bit is set, TDRE (bit 5) causes an \overline{IRQ}_2 interrupt. When cleared TDRE interrupt is masked.

Bit 3 RE (Receive Enable); When set, Port 2 bit 3 can be used as an input of receive regardless of DDR value for this bit. When cleared, the receiver is disabled.

Bit 4 RIE (Receive Interrupt Enable); When this bit is set, RDRF (bit 7) or ORFE (bit 6) cause an \overline{IRQ}_2 interrupt. When cleared, this interrupt is masked.

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Bit 5 TDRE (Transmit Data Register Empty); When the data is transferred from the Transmit Data Register to Output Shift Register, this bit is set by hardware. The bit is cleared by reading the status register followed by writing the next new data into the Transmit Data Register. TDRE is initialized to 1 by \overline{RES} .

Bit 6 ORFE (Over Run Framing Error); When overrun or framing error occurs (receive only), this bit is set by hardware. Over Run Error occurs if the attempt is made to transfer the new byte to the receive data register while the RDRF is "1". Framing Error occurs when the bit counter is not synchro-

nized with the boundary of the byte in the receiving bit stream. When Framing Error is detected, RDRF is not set. Therefore Framing Error can be distinguished from Overrun Error. That is, if ORFE is "1" and RDRF is "1", Overrun Error is detected. Otherwise Framing Error occurs. The bit is cleared by reading the status register followed by reading the receive data register, or by \overline{RES} .

Bit 7 RDRF (Receive Data Register Full); This bit is set by hardware when the data is transferred from the receive shift register to the receive data register. It is cleared by reading the status register followed by reading the receive data register, or by \overline{RES} .

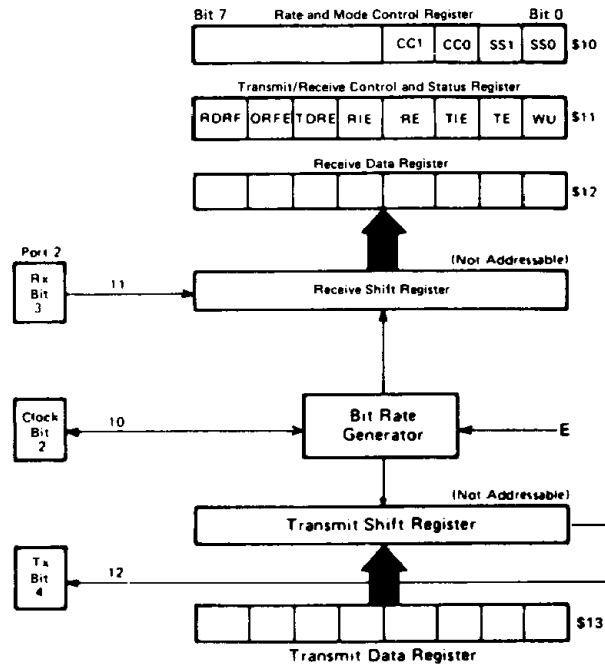


Figure 22 Serial I/O Register

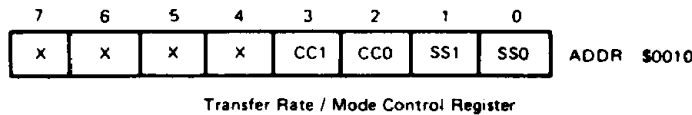


Table 6 SCI Bit Times and Transfer Rates

| SS1 : SS0 | XTAL | 2.4576 MHz | 4.0 MHz | 4.9152MHz |
|-----------|----------|------------------------|-------------------------|--------------------------|
| | E | 614.4 kHz | 1.0 MHz | 1.2288MHz |
| 0 0 | E ÷ 16 | 26 μ s/38,400 Baud | 16 μ s/62,500 Baud | 13 μ s/76,800Baud |
| 0 1 | E ÷ 128 | 208 μ s/4,800 Baud | 128 μ s/7812.5 Baud | 104.2 μ s/ 9,600Baud |
| 1 0 | E ÷ 1024 | 1.67ms/600 Baud | 1.024ms/976.6 Baud | 833.3 μ s/ 1,200Baud |
| 1 1 | E ÷ 4096 | 6.67ms/150 Baud | 4.096ms/244.1 Baud | 3.333ms/ 300Baud |

Table 7 SCI Format and Clock Source Control

| CC1: CC0 | Format | Clock Source | Port 2 Bit 2 | Port 2 Bit 3 | Port 2 Bit 4 |
|----------|--------|--------------|--------------|--------------|--------------|
| 0 0 | — | — | — | — | — |
| 0 1 | NRZ | Internal | Not Used *** | •• | •• |
| 1 0 | NRZ | Internal | Output * | •• | •• |
| 1 1 | NRZ | External | Input | •• | •• |

- * Clock output is available regardless of values for bits RE and TE.
- ** Bit 3 is used for serial input if RE = "1" in TRCS.
Bit 4 is used for serial output if TE = "1" in TRCS.
- *** This pin can be used as I/O port.

● **Transfer rate/Mode Control Register (RMCR)**

The register controls the following serial I/O functions:

- Bauds rate • data format • clock source
- Port 2 bit 2 feature

It is 4-bit write-only register, cleared by RES. The 4 bits are considered as a pair of 2-bit fields. The lower 2 bits control the bit rate of internal clock while the upper 2 bits control the format and the clock select logic.

Bit 0 SS0 }
Bit 1 SS1 } Speed Select

These bits select the Baud rate for the internal clock. The rates selectable are function of E clock frequency of the CPU. Table 6 lists the available Baud Rates.

Bit 2 CC0 }
Bit 3 CC1 } Clock Control/Format Select

They control the data format and the clock select logic. Table 7 defines the bit field.

● **Internally Generated Clock**

If the user wish to use externally an internal clock of the serial I/O, the following requirements should be noted.

- CC1, CC0 must be set to "10"
- The maximum clock rate must be E/16.
- The clock rate is equal to the bit rate.
- The values of RE and TE have no effect.

● **Externally Generated Clock**

If the user wish to supply an external clock to the Serial I/O, the following requirements should be noted.

- The CC1, CC0 must be set to "11" (See Table 7).
- The external clock must be set to 8 times of the desired baud rate.
- The maximum external clock frequency is E/2 clock.

● **Serial Operations**

The serial I/O hardware must be initialized by the software before operation. The sequence will be normally as follows.

- Writing the desired operation control bits of the Rate and Mode Control Register.
- Writing the desired operation control bits of the TRCS register.

If Port 2 bit 3, 4 are used for serial I/O, TE, RE bits may be kept set. When TE, RE bit are cleared during SCI operation, and subsequently set again, it should be noted that TE, RE must be kept "0" for at least one bit time of the current baud rate. If TE, RE are set again within one bit time, there may be the case where the initializing of internal function for transmitter and receiver does not take place correctly.

● **Transmit Operation**

Data transmission is enabled by the TE bit in the TRCS

register. When set, the output of the transmit shift register is connected with Port 2 bit 4 which is unconditionally configured as an output.

After RES, the user should initialize both the RMC register and the TRCS register for desired operation. Setting the TE bit causes a transmission of ten-bit preamble of "1"s. Following the preamble, internal synchronization is established and the transmitter is ready to operate. Then either of the following states exists.

- (1) If the transmit data register is empty (TDRE = 1), the consecutive "1"s are transmitted indicating an idle states.
- (2) If the data has been loaded into the Transmit Data Register (TDRE = 0), it is transferred to the output shift register and data transmission begins.

During the data transfer, the start bit ("0") is first transferred. Next the 8-bit data (beginning at bit 0) and finally the stop bit ("1"). When the contents of the Transmit Data Register is transferred to the output shift register, the hardware sets the TDRE flag bit: If the CPU fails to respond to the flag within the proper time, TDRE is kept set and then a continuous string of 1's is sent until the data is supplied to the data register.

● **Receive Operation**

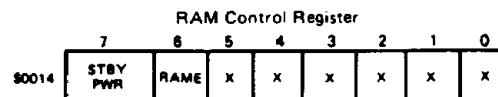
The receive operation is enabled by the RE bit. The serial input is connected with Port 2 bit 3. The receiver operation is determined by the contents of the TRCS and RMC register. The received bit stream is synchronized by the first "0" (start bit). During 10-bit time, the data is strobed approximately at the center of each bit. If the tenth bit is not "1" (stop bit), the system assumes a framing error and the ORFE is set.

If the tenth bit is "1", the data is transferred to the receive data register, and the RDRF flag is set. If the tenth bit of the next data is received and still RDRF is preserved set, then ORFE is set indicating that an overrun error has occurred.

After the CPU read of the status register as a response to RDRF flag or ORFE flag, followed by the CPU read of the receive data register, RDRF or ORFE will be cleared.

■ **RAM CONTROL REGISTER**

The register assigned to the address \$0014 gives a status information about standby RAM.



- Bit 0 Not used.
- Bit 1 Not used.
- Bit 2 Not used.

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- Bit 3 Not used.
- Bit 4 Not used.
- Bit 5 Not used.
- Bit 6 RAM Enable.

Using this control bit, the user can disable the RAM. RAM Enable bit is set on the positive edge of \overline{RES} and RAM is enabled. The program can write "1" or "0". If RAME is cleared, the RAM address becomes external address and the CPU may read the data from the outside memory.

Bit 7 Standby Bit

This bit can be read or written by the user program. It is cleared when the V_{CC} voltage is removed. Normally this bit is set by the program before going into stand-by mode. When the CPU recovers from stand-by mode, this bit should be checked. If it is "1", the data of the RAM is retained during stand-by and it is valid.

GENERAL DESCRIPTION OF INSTRUCTION SET

The HD6301V1 has an upward object code compatible with the HD6801 to utilize all instruction sets of the HMCS6800. The execution time of the key instruction is reduced to increase the system through-put. In addition, the bit operation instruction, the exchange instruction between the index and the accumulator, the sleep instruction are added. This section describes:

- CPU programming model (See Fig. 23)
- Addressing modes
- Accumulator and memory manipulation instructions (See Table 8)
- New instructions
- Index register and stack manipulation instructions (See Table 9)
- Jump and branch instructions (See Table 10)
- Condition code register manipulation instructions (See Table 11)
- Op-code map (See Table 12)
- Cycle-by-Cycle Operation (See Table 13)

• CPU Programming Model

The programming model for the HD6301V1 is shown in Figure 23. The double accumulator is physically the same as the accumulator A concatenated with the accumulator B, so that the contents of A and B is changed with executing operation of an accumulator D.

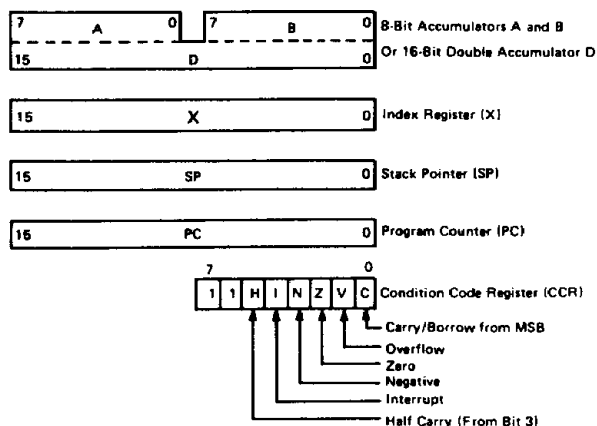


Figure 23 CPU Programming Model

• CPU Addressing Modes

The HD6301V1 has seven address modes which depend on both of the instruction type and the code. The address mode for every instruction is shown along with execution time given in terms of machine cycles (Table 8 to 12). When the clock frequency is 4 MHz, the machine cycles will be microseconds.

Accumulator (ACCX) Addressing

Only the accumulator (A or B) is addressed. Either accumulator A or B is specified by one-byte instructions.

Immediate Addressing

In this mode, the operand is stored in the second byte of the instruction except that the operand in LDS and LDX, etc are stored in the second and the third byte. These are two or three-byte instructions.

Direct Addressing

In this mode, the second byte of instruction indicates the address where the operand is stored. Direct addressing allows the user to directly address the lowest 256 Bytes in the machine locations zero through 255. Improved execution times are achieved by storing data in these locations. For system configuration, it is recommended that these locations should be RAM and be utilized preferably for user's data realm. These are two-byte instructions except the AIM, OIM, EIM and TIM which have three-byte.

Extended Addressing

In this mode, the second byte indicates the upper 8 bits addresses where the operand is stored, while the third byte indicates the lower 8 bits. This is an absolute address in memory. These are three-byte instructions.

Indexed Addressing

In this mode, the contents of the second byte is added to the lower 8 bits in the Index Register. For each of AIM, OIM, EIM and TIM instructions, the contents of the third byte are added to the lower 8 bits in the Index Register. In addition, the resulting "carry" is added to the upper 8 bits in the Index Register. The result is used for addressing memory. Because the modified address is held in the Temporary Address Register, there is no change to the Index Register. These are two-byte instructions but AIM, OIM, EIM, TIM have three-byte.

Implied Addressing

In this mode, the instruction itself gives the address; stack pointer, index register, etc. These are 1-byte instructions.

Relative Addressing

In this mode, the contents of the second byte is added to the lower 8 bits in the program counter. The resulting carry or borrow is added to the upper 8 bits. This helps the user to address the data within a range of -126 to +129 bytes of the current execution instruction. These are two-byte instructions.

Table 9 Index Register, Stack Manipulation Instructions

| Pointer Operations | Mnemonic | Addressing Modes | | | | | | | | | | Boolean/ Arithmetic Operation | Condition Code Register | | | | | | | | | | |
|-------------------------|----------|------------------|---|--------|----|-------|---|--------|---|---------|----|----------------------------------|-------------------------|----|---|---|--|---|---|---|---|---|---|
| | | IMMED. | | DIRECT | | INDEX | | EXTEND | | IMPLIED | | | 5 | 4 | 3 | 2 | 1 | 0 | | | | | |
| | | OP | # | OP | # | OP | # | OP | # | OP | # | | H | I | N | Z | V | C | | | | | |
| Compare Index Reg | CPX | BC | 3 | 3 | 9C | 4 | 2 | AC | 5 | 2 | BC | 5 | 3 | | | X - M, M + 1 | • | • | : | : | : | : | |
| Decrement Index Reg | DEX | | | | | | | | | | | | | 09 | 1 | 1 | X - 1 - X | • | • | • | • | • | • |
| Decrement Stack Pntr | DES | | | | | | | | | | | | | 34 | 1 | 1 | SP - 1 - SP | • | • | • | • | • | • |
| Increment Index Reg | INX | | | | | | | | | | | | | 08 | 1 | 1 | X + 1 - X | • | • | • | • | • | • |
| Increment Stack Pntr | INS | | | | | | | | | | | | | 31 | 1 | 1 | SP + 1 - SP | • | • | • | • | • | • |
| Load Index Reg | LDX | CE | 3 | 3 | DE | 4 | 2 | EE | 5 | 2 | FE | 5 | 3 | | | M - X _H , (M + 1) - X _L | • | • | • | • | • | • | |
| Load Stack Pntr | LOS | BE | 3 | 3 | 9E | 4 | 2 | AE | 5 | 2 | BE | 5 | 3 | | | M - SP _H , (M + 1) - SP _L | • | • | • | • | • | • | |
| Store Index Reg | STX | | | | DF | 4 | 2 | EF | 5 | 2 | FF | 5 | 3 | | | X _H - M, X _L - (M + 1) | • | • | • | • | • | • | |
| Store Stack Pntr | STS | | | | 9F | 4 | 2 | AF | 5 | 2 | BF | 5 | 3 | | | SP _H - M, SP _L - (M + 1) | • | • | • | • | • | • | |
| Index Reg -> Stack Pntr | TXS | | | | | | | | | | | | | 35 | 1 | 1 | X - 1 - SP | • | • | • | • | • | • |
| Stack Pntr -> Index Reg | TSX | | | | | | | | | | | | | 30 | 1 | 1 | SP + 1 - X | • | • | • | • | • | • |
| Add | ABX | | | | | | | | | | | | | 3A | 1 | 1 | B + X -> X | • | • | • | • | • | • |
| Push Data | PSHX | | | | | | | | | | | | | 3C | 5 | 1 | X _L -> M _{sp} , SP - 1 - SP X _H -> M _{sp} , SP - 1 - SP | • | • | • | • | • | • |
| Pull Data | PULX | | | | | | | | | | | | | 38 | 4 | 1 | SP + 1 -> SP, M _{sp} -> X _H SP + 1 -> SP, M _{sp} -> X _L | • | • | • | • | • | • |
| Exchange | XGDX | | | | | | | | | | | | | 18 | 2 | 1 | ACCD--IX | • | • | • | • | • | • |

Note) Condition Code Register will be explained in Note of Table 11.

Table 10 Jump, Branch Instruction

| Operations | Mnemonic | Addressing Modes | | | | | | | | | | Branch Test | Condition Code Register | | | | | | | | | | |
|--------------------------|----------|------------------|---|--------|----|-------|---|--------|----|---------|----|-------------|-------------------------|----|----|-----------------|---------------------------|---|---|---|---|---|---|
| | | RELATIVE | | DIRECT | | INDEX | | EXTEND | | IMPLIED | | | 5 | 4 | 3 | 2 | 1 | 0 | | | | | |
| | | OP | # | OP | # | OP | # | OP | # | OP | # | | H | I | N | Z | V | C | | | | | |
| Branch Always | BRA | 20 | 3 | 2 | | | | | | | | | | | | None | • | • | • | • | • | • | |
| Branch Never | BRN | 21 | 3 | 2 | | | | | | | | | | | | None | • | • | • | • | • | • | |
| Branch If Carry Clear | BCC | 24 | 3 | 2 | | | | | | | | | | | | C = 0 | • | • | • | • | • | • | |
| Branch If Carry Set | BCS | 25 | 3 | 2 | | | | | | | | | | | | C = 1 | • | • | • | • | • | • | |
| Branch If = Zero | BEO | 27 | 3 | 2 | | | | | | | | | | | | Z = 1 | • | • | • | • | • | • | |
| Branch If > Zero | BGE | 2C | 3 | 2 | | | | | | | | | | | | N ⊕ V = 0 | • | • | • | • | • | • | |
| Branch If > Zero | BGT | 2E | 3 | 2 | | | | | | | | | | | | Z + (N ⊕ V) = 0 | • | • | • | • | • | • | |
| Branch If Higher | BHI | 22 | 3 | 2 | | | | | | | | | | | | C + Z = 0 | • | • | • | • | • | • | |
| Branch If < Zero | BLE | 2F | 3 | 2 | | | | | | | | | | | | Z + (N ⊕ V) = 1 | • | • | • | • | • | • | |
| Branch If Lower Or Same | BLS | 23 | 3 | 2 | | | | | | | | | | | | C + Z = 1 | • | • | • | • | • | • | |
| Branch If < Zero | BLT | 2D | 3 | 2 | | | | | | | | | | | | N ⊕ V = 1 | • | • | • | • | • | • | |
| Branch If Minus | BMI | 28 | 3 | 2 | | | | | | | | | | | | N = 1 | • | • | • | • | • | • | |
| Branch If Not Equal Zero | BNE | 26 | 3 | 2 | | | | | | | | | | | | Z = 0 | • | • | • | • | • | • | |
| Branch If Overflow Clear | BVC | 28 | 3 | 2 | | | | | | | | | | | | V = 0 | • | • | • | • | • | • | |
| Branch If Overflow Set | BVS | 29 | 3 | 2 | | | | | | | | | | | | V = 1 | • | • | • | • | • | • | |
| Branch If Plus | BPL | 2A | 3 | 2 | | | | | | | | | | | | N = 0 | • | • | • | • | • | • | |
| Branch To Subroutine | BSR | 8D | 5 | 2 | | | | | | | | | | | | | | | | | | | |
| Jump | JMP | | | | | 6E | 3 | 2 | 7E | 3 | 3 | | | | | | | | | | | | |
| Jump To Subroutine | JSR | | | | 9D | 5 | 2 | AD | 5 | 2 | BD | 6 | 3 | | | | | | | | | | |
| No Operation | NOP | | | | | | | | | | | | | 01 | 1 | 1 | Advances Prog. Cntr. Only | • | • | • | • | • | • |
| Return From Interrupt | RTI | | | | | | | | | | | | | 3B | 10 | 1 | | | | | | | |
| Return From Subroutine | RTS | | | | | | | | | | | | | 39 | 5 | 1 | | | | | | | |
| Software Interrupt | SWI | | | | | | | | | | | | | 3F | 12 | 1 | | | | | | | |
| Wait for Interrupt* | WAI | | | | | | | | | | | | | 3E | 9 | 1 | | | | | | | |
| Sleep | SLP | | | | | | | | | | | | | 1A | 4 | 1 | | | | | | | |

Note) *WAI puts R/W high; Address Bus goes to FFFF; Data Bus goes to the three state
Condition Code Register will be explained in Note of Table 11.



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Table 11 Condition Code Register Manipulation Instructions

| Operations | Mnemonic | Addressing Modes | | | Boolean Operation | Condition Code Register | | | | | |
|----------------------|----------|------------------|----|---|-------------------|-------------------------|---|---|---|---|---|
| | | IMPLIED | OP | ~ | | # | 5 | 4 | 3 | 2 | 1 |
| | | | | | | H | I | N | Z | V | C |
| Clear Carry | CLC | 0C | 1 | 1 | 0 → C | • | • | • | • | • | R |
| Clear Interrupt Mask | CLI | 0E | 1 | 1 | 0 → I | • | R | • | • | • | • |
| Clear Overflow | CLV | 0A | 1 | 1 | 0 → V | • | • | • | • | R | • |
| Set Carry | SEC | 0D | 1 | 1 | 1 → C | • | • | • | • | • | S |
| Set Interrupt Mask | SEI | 0F | 1 | 1 | 1 → I | • | S | • | • | • | • |
| Set Overflow | SEV | 08 | 1 | 1 | 1 → V | • | • | • | • | S | • |
| Accumulator A → CCR | TAP | 06 | 1 | 1 | A → CCR | 10 | | | | | |
| CCR → Accumulator A | TPA | 07 | 1 | 1 | CCR → A | • | • | • | • | • | • |

- [NOTE 1] Condition Code Register Notes: {Bit set if test is true and cleared otherwise}
- ① (Bit V) Test: Result = 1000000?
 - ② (Bit C) Test: Result ≠ 0000000?
 - ③ (Bit C) Test: BCD Character of high-order byte greater than 9? (Not cleared if previously set)
 - ④ (Bit V) Test: Operand = 1000000 prior to execution?
 - ⑤ (Bit V) Test: Operand = 0111111 prior to execution?
 - ⑥ (Bit V) Test: Set equal to N⊖C-1 after the execution of instructions
 - ⑦ (Bit N) Test: Result less than zero? (Bit 15=1)
 - ⑧ (All Bit) Load Condition Code Register from Stack.
 - ⑨ (Bit I) Set when interrupt occurs. If previously set, a Non-Maskable Interrupt is required to exit the wait state.
 - ⑩ (All Bit) Set according to the contents of Accumulator A.
 - ⑪ (Bit C) Result of Multiplication Bit 7=1 of ACCB?
- [NOTE 2] CLI instructions and interrupt.
 If interrupt mask-bit is set (1="1") and interrupt is requested (IRQ₁ = "0" or IRQ₂ = "0"), and then CLI instruction is executed, the CPU responds as follows.
- 1 the next instruction of CLI is one-machine cycle instruction.
 Subsequent two instructions are executed before the interrupt is responded.
 That is, the next and the next of the next instruction are executed.
 - 2 the next instruction of CLI is two-machine cycle (or more) instruction.
 Only the next instruction is executed and then the CPU jump to the interrupt routine.
 Even if TAP instruction is used, instead of CLI, the same thing occurs.

Table 12 OP-Code Map

| OP CODE | | | | | ACC A | | ACC B | | IND | EXT DIR | ACCA or SP | | | | ACCB or X | | | |
|---------|----|------|------|------|-------|------|-------|------|------|---------|------------|-----|-----|-----|-----------|-----|-----|--|
| | HI | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | IMM | DIR | IND | EXT | IMM | DIR | IND | EXT | |
| LO | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F | | |
| 0000 | 0 | SBA | BRA | TSX | NEG | | | | SUB | | | | | | | | | |
| 0001 | 1 | NOP | CBA | BRN | INS | AIM | | | | CMP | | | | | | | | |
| 0010 | 2 | | BHI | PULA | OIM | | | | SBC | | | | | | | | | |
| 0011 | 3 | | BLS | PULB | COM | | | | SUBD | | | | ADD | | | | | |
| 0100 | 4 | LSRD | | BCC | DES | LSR | | | | AND | | | | | | | | |
| 0101 | 5 | ASLD | | BCS | TXS | EIM | | | | BIT | | | | | | | | |
| 0110 | 6 | TAP | TAB | BNE | PSHA | ROR | | | | LDA | | | | | | | | |
| 0111 | 7 | TPA | TBA | BEQ | PSHB | ASR | | | | STA | | | | STA | | | | |
| 1000 | 8 | INX | XGDX | BVC | PULX | ASL | | | | EOR | | | | | | | | |
| 1001 | 9 | DEX | DAA | BVS | RTS | ROL | | | | ADC | | | | | | | | |
| 1010 | A | CLV | SLP | BPL | ABX | DEC | | | | ORA | | | | | | | | |
| 1011 | B | SEV | ABA | BMI | RTI | TIM | | | | ADD | | | | | | | | |
| 1100 | C | CLC | | BGE | PSHX | INC | | | | CPX | | | | LDD | | | | |
| 1101 | D | SEC | | BLT | MUL | TST | | | | BSR | | | | JSR | | | | |
| 1110 | E | CLI | | BGT | WAI | JMP | | | | LDS | | | | LDX | | | | |
| 1111 | F | SEI | | BLE | SWI | CLR | | | | STS | | | | STX | | | | |

UNDEFINED OP CODE * Only for instructions of AIM, OIM, EIM, TIM



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• **Instruction Execution Cycles**

In the HMCS6800 series, the execution cycle of each instruction is the number of cycles between the start of the current instruction fetch and just before the start of the subsequent instruction fetch.

The HD6301V1 uses a mechanism of the pipeline control for the instruction fetch and the subsequent instruction fetch is performed during the current instruction being exe-

cuted.

Therefore, the method to count instruction cycles used in the HMCS6800 series cannot be applied to the instruction cycles such as MULT, PULL, DAA and XGDX in the HD6301V1.

Table 13 provides the information about the relationship among each data on the Address Bus, Data Bus, and R/W status in cycle-by-cycle basis during the execution of each instruction.

Table 13 Cycle-by-Cycle Operation

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W | Data Bus |
|-----------------------------|--------|---------|-----------------------|-----|---------------------------|
| IMMEDIATE | | | | | |
| ADC ADD | 2 | 1 | Op Code Address+1 | 1 | Operand Data |
| AND BIT | | 2 | Op Code Address+2 | 1 | Next Op Code |
| CMP EOR | | | | | |
| LDA ORA | | | | | |
| SBC SUB | | | | | |
| ADDD CPX | 3 | 1 | Op Code Address+1 | 1 | Operand Data (MSB) |
| LDD LDS | | 2 | Op Code Address+2 | 1 | Operand Data (LSB) |
| LDX SUBD | | 3 | Op Code Address+3 | 1 | Next Op Code |
| DIRECT | | | | | |
| ADC ADD | 3 | 1 | Op Code Address+1 | 1 | Address of Operand (LSB) |
| AND BIT | | 2 | Address of Operand | 1 | Operand Data |
| CMP EOR | | 3 | Op Code Address+2 | 1 | Next Op Code |
| LDA ORA | | | | | |
| SBC SUB | | | | | |
| STA | 3 | 1 | Op Code Address+1 | 1 | Destination Address |
| | | 2 | Destination Address | 0 | Accumulator Data |
| | | 3 | Op Code Address+2 | 1 | Next Op Code |
| ADDD CPX | 4 | 1 | Op Code Address+1 | 1 | Address of Operand (LSB) |
| LDD LDS | | 2 | Address of Operand | 1 | Operand Data (MSB) |
| LDX SUBD | | 3 | Address of Operand+1 | 1 | Operand Data (LSB) |
| | | 4 | Op Code Address+2 | 1 | Next Op Code |
| STD STS | 4 | 1 | Op Code Address+1 | 1 | Destination Address (LSB) |
| STX | | 2 | Destination Address | 0 | Register Data (MSB) |
| | | 3 | Destination Address+1 | 0 | Register Data (LSB) |
| | | 4 | Op Code Address+2 | 1 | Next Op Code |
| JSR | 5 | 1 | Op Code Address+1 | 1 | Jump Address (LSB) |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | 3 | Stack Pointer | 0 | Return Address (LSB) |
| | | 4 | Stack Pointer-1 | 0 | Return Address (MSB) |
| | | 5 | Jump Address | 1 | First Subroutine Op Code |
| TIM | 4 | 1 | Op Code Address+1 | 1 | Immediate Data |
| | | 2 | Op Code Address+2 | 1 | Address of Operand (LSB) |
| | | 3 | Address of Operand | 1 | Operand Data |
| | | 4 | Op Code Address+3 | 1 | Next Op Code |
| AIM EIM | 6 | 1 | Op Code Address+1 | 1 | Immediate Data |
| OIM | | 2 | Op Code Address+2 | 1 | Address of Operand (LSB) |
| | | 3 | Address of Operand | 1 | Operand Data |
| | | 4 | FFFF | 1 | Restart Address (LSB) |
| | | 5 | Address of Operand | 0 | New Operand Data |
| | | 6 | Op Code Address+3 | 1 | Next Op Code |

- Continued -



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Table 13 Cycle-by-Cycle Operation (Continued)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W | Data Bus |
|--|--------|---------------------|---------------------|-----------------------|-------------------------------|
| INDEXED | | | | | |
| JMP | 3 | 1 | Op Code Address + 1 | 1 | Offset |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | 3 | Jump Address | 1 | First Op Code of Jump Routine |
| ADC ADD AND BIT CMP EOR LDA ORA SBC SUB TST | 4 | 1 | Op Code Address + 1 | 1 | Offset |
| 2 | | FFFF | 1 | Restart Address (LSB) | |
| 3 | | IX + Offset | 1 | Operand Data | |
| 4 | | Op Code Address + 2 | 1 | Next Op Code | |
| STA | 4 | 1 | Op Code Address + 1 | 1 | Offset |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | 3 | IX + Offset | 0 | Accumulator Data |
| | | 4 | Op Code Address + 2 | 1 | Next Op Code |
| ADDD CPX LDD LDS LDX SUBD | 5 | 1 | Op Code Address + 1 | 1 | Offset |
| 2 | | FFFF | 1 | Restart Address (LSB) | |
| 3 | | IX + Offset | 1 | Operand Data (MSB) | |
| 4 | | IX + Offset + 1 | 1 | Operand Data (LSB) | |
| 5 | | Op Code Address + 2 | 1 | Next Op Code | |
| STD STS STX | 5 | 1 | Op Code Address + 1 | 1 | Offset |
| 2 | | FFFF | 1 | Restart Address (LSB) | |
| 3 | | IX + Offset | 0 | Register Data (MSB) | |
| 4 | | IX + Offset + 1 | 0 | Register Data (LSB) | |
| 5 | | Op Code Address + 2 | 1 | Next Op Code | |
| JSR | 5 | 1 | Op Code Address + 1 | 1 | Offset |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | 3 | Stack Pointer | 0 | Return Address (LSB) |
| | | 4 | Stack Pointer - 1 | 0 | Return Address (MSB) |
| | | 5 | IX + Offset | 1 | First Subroutine Op Code |
| ASL ASR COM DEC INC LSR NEG ROL ROR | 6 | 1 | Op Code Address + 1 | 1 | Offset |
| 2 | | FFFF | 1 | Restart Address (LSB) | |
| 3 | | IX + Offset | 1 | Operand Data | |
| 4 | | FFFF | 1 | Restart Address (LSB) | |
| 5 | | IX + Offset | 0 | New Operand Data | |
| 6 | | Op Code Address + 2 | 1 | Next Op Code | |
| TIM | 5 | 1 | Op Code Address + 1 | 1 | Immediate Data |
| | | 2 | Op Code Address + 2 | 1 | Offset |
| | | 3 | FFFF | 1 | Restart Address (LSB) |
| | | 4 | IX + Offset | 1 | Operand Data |
| | | 5 | Op Code Address + 3 | 1 | Next Op Code |
| CLR | 5 | 1 | Op Code Address + 1 | 1 | Offset |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | 3 | IX + Offset | 1 | Operand Data |
| | | 4 | IX + Offset | 0 | 00 |
| | | 5 | Op Code Address + 2 | 1 | Next Op Code |
| AIM EIM OIM | 7 | 1 | Op Code Address + 1 | 1 | Immediate Data |
| 2 | | Op Code Address + 2 | 1 | Offset | |
| 3 | | FFFF | 1 | Restart Address (LSB) | |
| 4 | | IX + Offset | 1 | Operand Data | |
| 5 | | FFFF | 1 | Restart Address (LSB) | |
| 6 | | IX + Offset | 0 | New Operand Data | |
| 7 | | Op Code Address + 3 | 1 | Next Op Code | |

- Continued -



Table 13 Cycle-by-Cycle Operation (Continued)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/W | Data Bus |
|---|--------|---------|-------------------------|-----|---------------------------|
| EXTEND | | | | | |
| JMP | 3 | 1 | Op Code Address + 1 | 1 | Jump Address (MSB) |
| | | 2 | Op Code Address + 2 | 1 | Jump Address (LSB) |
| | | 3 | Jump Address | 1 | Next Op Code |
| ADC ADD TST AND BIT CMP EOR LDA ORA SBC SUB | 4 | 1 | Op Code Address + 1 | 1 | Address of Operand (MSB) |
| | | 2 | Op Code Address + 2 | 1 | Address of Operand (LSB) |
| | | 3 | Address of Operand | 1 | Operand Data |
| | | 4 | Op Code Address + 3 | 1 | Next Op Code |
| STA | 4 | 1 | Op Code Address + 1 | 1 | Destination Address (MSB) |
| | | 2 | Op Code Address + 2 | 1 | Destination Address (LSB) |
| | | 3 | Destination Address | 0 | Accumulator Data |
| | | 4 | Op Code Address + 3 | 1 | Next Op Code |
| ADDD CPX LDD LDS LDX SUBD | 5 | 1 | Op Code Address + 1 | 1 | Address of Operand (MSB) |
| | | 2 | Op Code Address + 2 | 1 | Address of Operand (LSB) |
| | | 3 | Address of Operand | 1 | Operand Data (MSB) |
| | | 4 | Address of Operand + 1 | 1 | Operand Data (LSB) |
| | | 5 | Op Code Address + 3 | 1 | Next Op Code |
| STD STS STX | 5 | 1 | Op Code Address + 1 | 1 | Destination Address (MSB) |
| | | 2 | Op Code Address + 2 | 1 | Destination Address (LSB) |
| | | 3 | Destination Address | 0 | Register Data (MSB) |
| | | 4 | Destination Address + 1 | 0 | Register Data (LSB) |
| | | 5 | Op Code Address + 3 | 1 | Next Op Code |
| JSR | 6 | 1 | Op Code Address + 1 | 1 | Jump Address (MSB) |
| | | 2 | Op Code Address + 2 | 1 | Jump Address (LSB) |
| | | 3 | FFFF | 1 | Restart Address (LSB) |
| | | 4 | Stack Pointer | 0 | Return Address (LSB) |
| | | 5 | Stack Pointer - 1 | 0 | Return Address (MSB) |
| | | 6 | Jump Address | 1 | First Subroutine Op Code |
| ASL ASR COM DEC INC LSR NEG ROL ROR | 6 | 1 | Op Code Address + 1 | 1 | Address of Operand (MSB) |
| | | 2 | Op Code Address + 2 | 1 | Address of Operand (LSB) |
| | | 3 | Address of Operand | 1 | Operand Data |
| | | 4 | FFFF | 1 | Restart Address (LSB) |
| | | 5 | Address of Operand | 0 | New Operand Data |
| | | 6 | Op Code Address + 3 | 1 | Next Op Code |
| CLR | 5 | 1 | Op Code Address + 1 | 1 | Address of Operand (MSB) |
| | | 2 | Op Code Address + 2 | 1 | Address of Operand (LSB) |
| | | 3 | Address of Operand | 1 | Operand Data |
| | | 4 | Address of Operand | 0 | 00 |
| | | 5 | Op Code Address + 3 | 1 | Next Op Code |

- Continued -

HD6301V1, HD63A01V1, HD63B01V1

Table 13 Cycle-by-Cycle Operation (Continued)

| Address Mode & Instructions | | Cycles | Cycle # | Address Bus | R/W | Data Bus | |
|-----------------------------|--|--------|---------|---------------------|-----|---------------------------------|--|
| IMPLIED | | | | | | | |
| ABA ABX | | 1 | 1 | Op Code Address + 1 | 1 | Next Op Code | |
| ASL ASLD | | | | | | | |
| ASR CBA | | | | | | | |
| CLC CLI | | | | | | | |
| CLR CLV | | | | | | | |
| COM DEC | | | | | | | |
| DES DEX | | | | | | | |
| INC INS | | | | | | | |
| INX LSR | | | | | | | |
| LSRD ROL | | | | | | | |
| ROR NOP | | | | | | | |
| SBA SEC | | | | | | | |
| SEI SEV | | | | | | | |
| TAB TAP | | | | | | | |
| TBA TPA | | | | | | | |
| TST TSX | | | | | | | |
| TXS | | | | | | | |
| DAA XGDX | | 2 | 1 | Op Code Address + 1 | 1 | Next Op Code | |
| | | | 2 | FFFF | 1 | Restart Address (LSB) | |
| PULA PULB | | 3 | 1 | Op Code Address + 1 | 1 | Next Op Code | |
| | | | 2 | FFFF | 1 | Restart Address (LSB) | |
| | | | 3 | Stack Pointer + 1 | 1 | Data from Stack | |
| PSHA PSHB | | 4 | 1 | Op Code Address + 1 | 1 | Next Op Code | |
| | | | 2 | FFFF | 1 | Restart Address (LSB) | |
| | | | 3 | Stack Pointer | 0 | Accumulator Data | |
| | | | 4 | Op Code Address + 1 | 1 | Next Op Code | |
| PULX | | 4 | 1 | Op Code Address + 1 | 1 | Next Op Code | |
| | | | 2 | FFFF | 1 | Restart Address (LSB) | |
| | | | 3 | Stack Pointer + 1 | 1 | Data from Stack (MSB) | |
| | | | 4 | Stack Pointer + 2 | 1 | Data from Stack (LSB) | |
| PSHX | | 5 | 1 | Op Code Address + 1 | 1 | Next Op Code | |
| | | | 2 | FFFF | 1 | Restart Address (LSB) | |
| | | | 3 | Stack Pointer | 0 | Index Register (LSB) | |
| | | | 4 | Stack Pointer - 1 | 0 | Index Register (MSB) | |
| | | | 5 | Op Code Address + 1 | 1 | Next Op Code | |
| RTS | | 5 | 1 | Op Code Address + 1 | 1 | Next Op Code | |
| | | | 2 | FFFF | 1 | Restart Address (LSB) | |
| | | | 3 | Stack Pointer + 1 | 1 | Return Address (MSB) | |
| | | | 4 | Stack Pointer + 2 | 1 | Return Address (LSB) | |
| | | | 5 | Return Address | 1 | First Op Code of Return Routine | |
| MUL | | 7 | 1 | Op Code Address + 1 | 1 | Next Op Code | |
| | | | 2 | FFFF | 1 | Restart Address (LSB) | |
| | | | 3 | FFFF | 1 | Restart Address (LSB) | |
| | | | 4 | FFFF | 1 | Restart Address (LSB) | |
| | | | 5 | FFFF | 1 | Restart Address (LSB) | |
| | | | 6 | FFFF | 1 | Restart Address (LSB) | |
| | | | 7 | FFFF | 1 | Restart Address (LSB) | |

- Continued -



HD6301V1, HD63A01V1, HD63B01V1

Table 13 Cycle-by-Cycle Operation (Continued)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/ \bar{W} | Data Bus |
|-----------------------------|--------|---------|------------------------|--------------|--|
| IMPLIED | | | | | |
| WAI | 9 | 1 | Op Code Address + 1 | 1 | Next Op Code |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | 3 | Stack Pointer | 0 | Return Address (LSB) |
| | | 4 | Stack Pointer - 1 | 0 | Return Address (MSB) |
| | | 5 | Stack Pointer - 2 | 0 | Index Register (LSB) |
| | | 6 | Stack Pointer - 3 | 0 | Index Register (MSB) |
| | | 7 | Stack Pointer - 4 | 0 | Accumulator A |
| | | 8 | Stack Pointer - 5 | 0 | Accumulator B |
| | | 9 | Stack Pointer - 6 | 0 | Conditional Code Register |
| RTI | 10 | 1 | Op Code Address + 1 | 1 | Next Op Code |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | 3 | Stack Pointer + 1 | 1 | Conditional Code Register |
| | | 4 | Stack Pointer + 2 | 1 | Accumulator B |
| | | 5 | Stack Pointer + 3 | 1 | Accumulator A |
| | | 6 | Stack Pointer + 4 | 1 | Index Register (MSB) |
| | | 7 | Stack Pointer + 5 | 1 | Index Register (LSB) |
| | | 8 | Stack Pointer + 6 | 1 | Return Address (MSB) |
| | | 9 | Stack Pointer + 7 | 1 | Return Address (LSB) |
| | | 10 | Return Address | 1 | First Op Code of Return Routine |
| SWI | 12 | 1 | Op Code Address + 1 | 1 | Next Op Code |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | 3 | Stack Pointer | 0 | Return Address (LSB) |
| | | 4 | Stack Pointer - 1 | 0 | Return Address (MSB) |
| | | 5 | Stack Pointer - 2 | 0 | Index Register (LSB) |
| | | 6 | Stack Pointer - 3 | 0 | Index Register (MSB) |
| | | 7 | Stack Pointer - 4 | 0 | Accumulator A |
| | | 8 | Stack Pointer - 5 | 0 | Accumulator B |
| | | 9 | Stack Pointer - 6 | 0 | Conditional Code Register |
| | | 10 | Vector Address FFFA | 1 | Address of SWI Routine (MSB) |
| | | 11 | Vector Address FFFB | 1 | Address of SWI Routine (LSB) |
| | | 12 | Address of SWI Routine | 1 | First Op Code of SWI Routine |
| SLP | 4 | 1 | Op Code Address + 1 | 1 | Next Op Code |
| | | 2 | FFFF | 1 | Restart Address (LSB) |
| | | Sleep | | | High Impedance-Non MPX Mode Address Bus -MPX Mode |
| | | 3 | FFFF | | Restart Address (LSB) |
| | | 4 | Op Code Address + 1 | | Next Op Code |

- Continued -



Table 13 Cycle-by-Cycle Operation (Continued)

| Address Mode & Instructions | Cycles | Cycle # | Address Bus | R/ \bar{W} | Data Bus | |
|-----------------------------|--------|---------|-------------------|---|-----------------------------|---|
| RELATIVE | | | | | | |
| BCC BCS | 3 | 1 | Op Code Address+1 | 1 | Branch Offset | |
| BEQ BGE | | 2 | FFFF | 1 | Restart Address (LSB) | |
| BGT BHI | | 3 | 3 | { Branch Address...Test="1" Op Code Address+1...Test="0" | 1 | First Op Code of Branch Routine Next Op Code |
| BLE BLS | | | | | | |
| BLT BMT | | | | | | |
| BNE BPL | | | | | | |
| BRA BRN | | | | | | |
| BVC BVS | | | | | | |
| BSR | 5 | 1 | Op Code Address+1 | 1 | Offset | |
| | | 2 | FFFF | 1 | Restart Address (LSB) | |
| | | 3 | Stack Pointer | 0 | Return Address (LSB) | |
| | | 4 | Stack Pointer - 1 | 0 | Return Address (MSB) | |
| | | 5 | Branch Address | 1 | First Op Code of Subroutine | |

■ **LOW POWER CONSUMPTION MODE**

The HD6301V1 has two low power consumption modes; sleep and standby mode.

● **Sleep Mode**

On execution of SLP instruction, the MCU is brought to the sleep mode. In the sleep mode, the CPU sleeps (the CPU clock becomes inactive), but the contents of the registers in the CPU are retained. In this mode, the peripherals of CPU will remain active. So the operations such as transmit and receive of the SCI data and counter may keep in operation. In this mode, the power consumption is reduced to about 1/6 the value of a normal operation.

The escape from this mode can be done by interrupt, \overline{RES} , \overline{STBY} . The \overline{RES} resets the MCU and the \overline{STBY} brings it into the standby mode (This will be mentioned later). When interrupt is requested to the CPU and accepted, the sleep mode is released, then the CPU is brought in the operation mode and jumps to the interrupt routine. When the CPU has masked the interrupt, after recovering from the sleep mode, the next instruction of SLP starts to execute. However, in such a case that the timer interrupt is inhibited on the timer side, the sleep mode cannot be released due to the absence of the interrupt request to the

CPU.

This sleep mode is available to reduce an average power consumption in the applications of the HD6301V1 which may not be always running.

● **Standby Mode**

Bringing \overline{STBY} "Low", the CPU becomes reset and all clocks of the HD6301V1 become inactive. It goes into the standby mode. This mode remarkably reduces the power consumptions of the HD6301V1.

In the standby mode, if the HD6301V1 is continuously supplied with power, the contents of RAM is retained. The standby mode should escape by the reset start. The following is the typical application of this mode.

First, \overline{NMI} routine stacks the MCU's internal information and the contents of SP in RAM, disables RAME bit of RAM control register, sets the Standby bit, and then goes into the standby mode. If the Standby bit keeps set on reset start, it means that the power has been kept during standby mode and the contents of RAM is normally guaranteed. The system recovery may be possible by returning SP and bringing into the condition before the standby mode has started. The timing relation for each line in this application is shown in Figure 24.

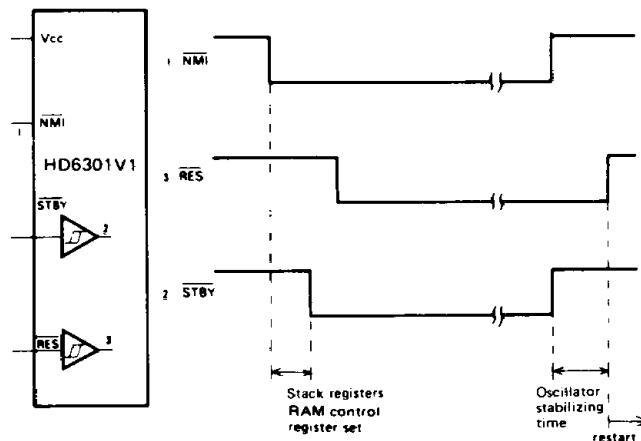


Figure 24 Standby Mode Timing

■ **ERROR PROCESSING**

When the HD6301V1 fetches an undefined instruction or fetches an instruction from unusable memory area, it generates the highest priority internal interrupt, that may protect from system upset due to noise or a program error.

● **Op-Code Error**

Fetching an undefined op-code, the HD6301V1 will stack the CPU register as in the case of a normal interrupt and vector to the TRAP (\$FFEE, \$FFEF), that has a second highest priority (RES is the highest).

● **Address Error**

When an instruction is fetched from other than a resident ROM, RAM, or an external memory area, the CPU starts the same interrupt as op-code error. In the case which the instruction is fetched from external memory area and that area is not usable, the address error cannot be detected.

The addresses which cause address error in particular mode are shown in Table 14.

This feature is applicable only to the instruction fetch, not to normal read/write of data accessing.

Table 14 Address Error

| Mode | 0 | 1 | 2, 4 | 5 | 6 | 7 |
|---------|--------|--------|--------|--------|--------|--------|
| | \$0000 | \$0000 | \$0000 | \$0000 | \$0000 | \$0000 |
| | | | | | | |
| Address | \$001F | \$001F | \$001F | \$007F | \$001F | \$007F |
| | | | | \$0200 | | \$0100 |
| | | | | | | |
| | | | | \$EFFF | | \$EFFF |

System Flow chart of HD6301V1 is shown in Fig. 25.

Transitions among the active mode, sleep mode, standby mode and reset are shown in Fig. 26.

Figures 27, 28, 29 and 30 shows a system configuration.

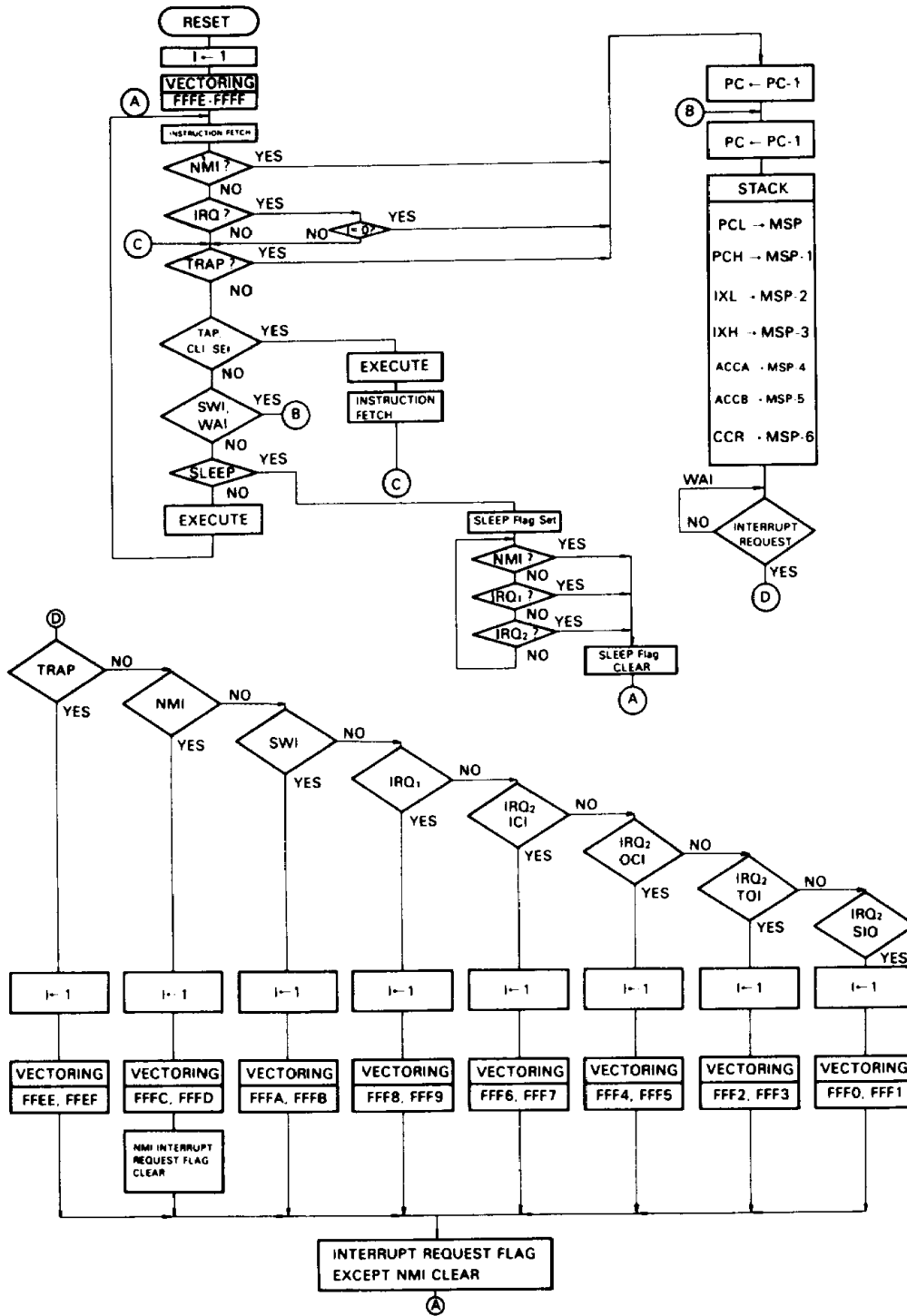


Figure 25 HD6301V1 System Flow Chart

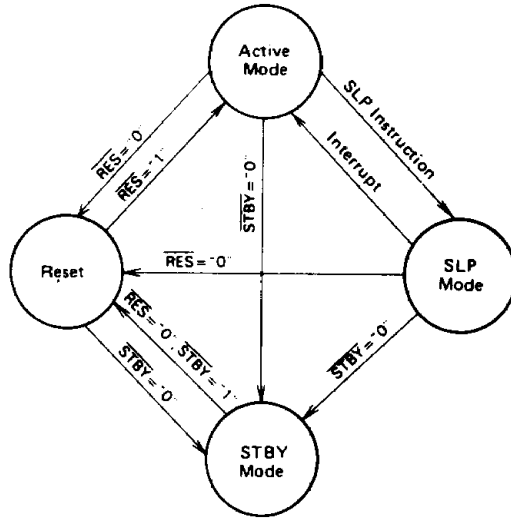


Figure 26 Transitions among Active Mode, Standby Mode, Sleep Mode, and Reset

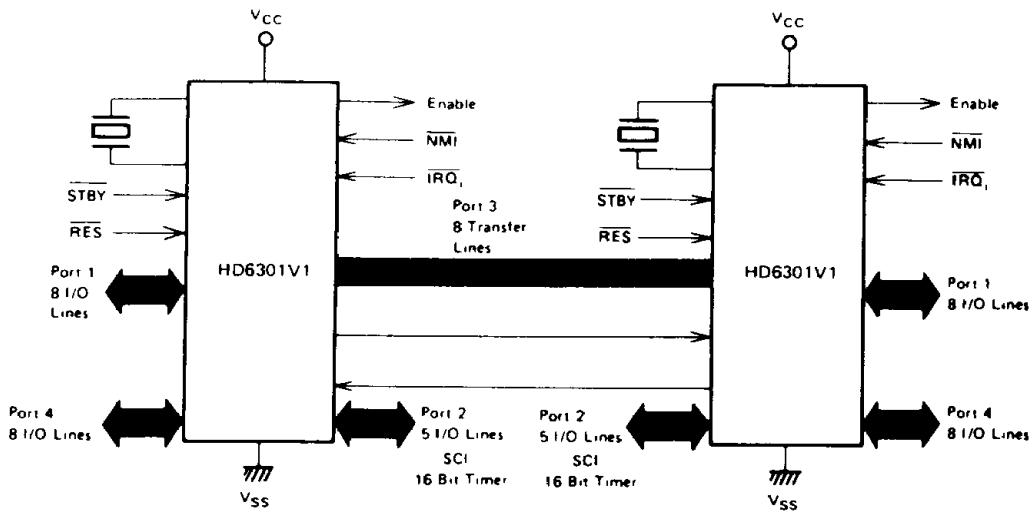


Figure 27 HD6301V1 MCU Single-Chip Dual Processor Configuration

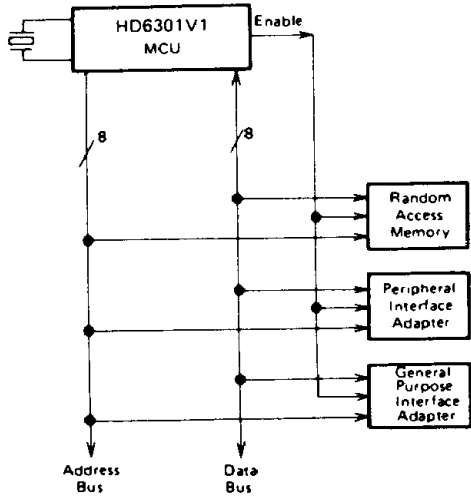


Figure 28 HD6301V1 MCU Expanded Non-Multiplexed Mode (Mode 5)

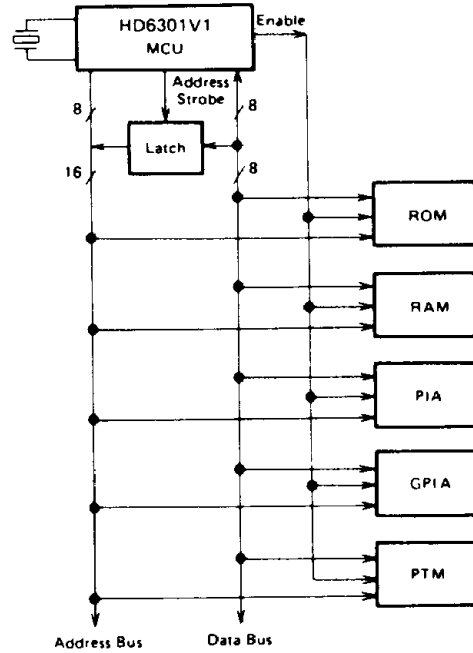


Figure 29 HD6301V1 MCU Expanded Multiplexed Mode

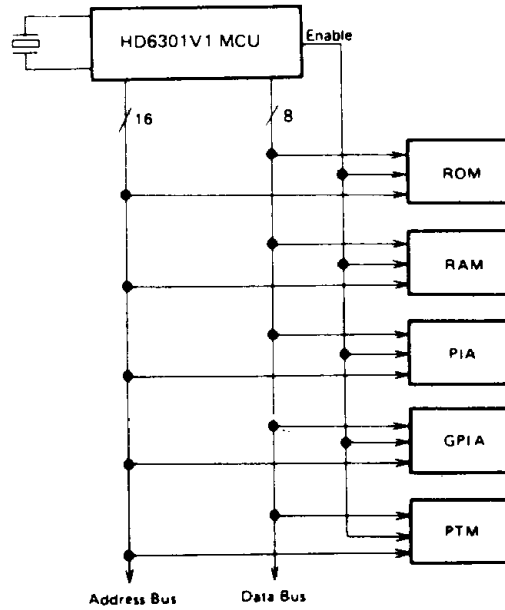
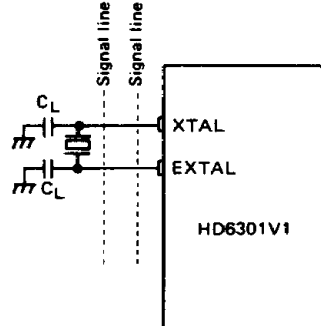


Figure 30 HD6301V1 MCU Expanded Non-Multiplexed Mode (Mode 1)

PRECAUTION TO THE BOARD DESIGN OF OSCILLATION CIRCUIT

As shown in Fig. 31, there is a case that the cross talk disturbs the normal oscillation if signal lines are put near the oscillation circuit. When designing a board, pay attention to this. Crystal and C_L must be put as near the HD6301V1 as possible.



Do not use this kind of print board design.

Figure 31 Precaution to the board design of oscillation circuit

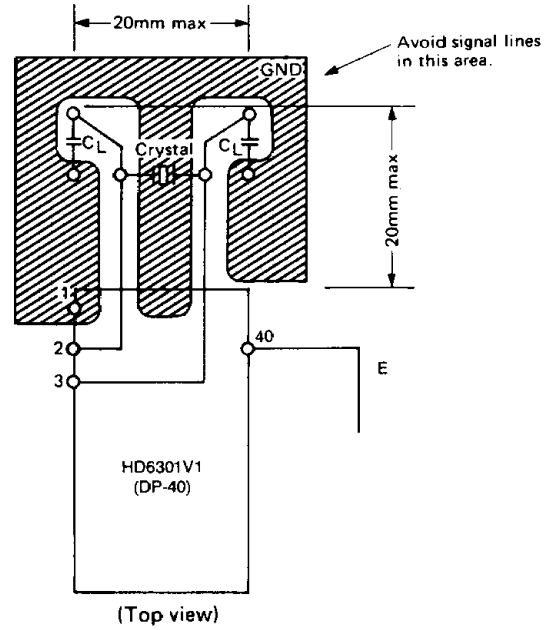


Figure 32 Example of Oscillation Circuits in Board Design

Table 15 Pin Condition in Sleep Mode

| Pin | Mode | 0 | 1 | 2, 4 | 5 | 6 | 7 |
|--|-----------|--|-------------------|--|---|--|--------------------------------------|
| Port 1 P ₁₀ ~P ₁₇ | Function | I/O Port | Lower Address Bus | I/O Port | ← | ← | ← |
| | Condition | Keep the condition just before sleep | Output "1" | Keep the condition just before sleep | ← | ← | ← |
| Port 2 P ₃₀ ~P ₃₄ | Function | I/O Port | ← | ← | ← | ← | ← |
| | Condition | Keep the condition just before sleep | ← | ← | ← | ← | ← |
| Port 3 P ₃₀ ~P ₃₃ | Function | \bar{E} : Lower Address Bus E: Data Bus | Data Bus | \bar{E} : Lower Address Bus E: Data Bus | Data Bus | \bar{E} : Lower Address Bus E: Data Bus | I/O Port |
| | Condition | \bar{E} : Output "1" E: High Impedance | High Impedance | \bar{E} : Output "1" E: High Impedance | High Impedance | \bar{E} : Output "1" E: High Impedance | Keep the condition just before sleep |
| Port 4 P ₄₀ ~P ₄₇ | Function | Upper Address | ← | ← | Lower Address Bus or Input Port | Upper Address Bus or Input Port | I/O Port |
| | Condition | Output "1" | ← | ← | Address Bus: Output "1" Port: Keep the condition just before sleep | ← | Keep the condition just before sleep |
| SC ₂ | | Output "1" (Read Condition) | ← | ← | ← | ← | Output "1" |
| SC ₁ | | Output Address Strobe | ← | ← | Output "1" | Output Address Strobe | Input Pin |

HD6301V1, HD63A01V1, HD63B01V1

Table 16 Pin Condition during RESET

| Pin \ Mode | 0 | 1 | 2, 4 | 5 | 6 | 7 |
|---|---|----------------|---|----------------|---|---------------------------|
| Port 1 P ₁₀ ~ P ₁₇ | high impedance (input) | ← | ← | ← | ← | ← |
| Port 2 P ₂₀ ~ P ₂₄ | high impedance (input) | ← | ← | ← | ← | ← |
| Port 3 P ₃₀ ~ P ₃₇ | \bar{E} : "1" output E: "1" output ^(Note) (high impedance) | high impedance | \bar{E} : "1" output ^(Note) E: "1" output (high impedance) | high impedance | \bar{E} : "1" output ^(Note) E: "1" output ^(Note) (high impedance) | high impedance (input) |
| Port 4 P ₄₀ ~ P ₄₇ | high impedance (input) | ← | ← | ← | ← | ← |
| SC ₂ | "1" output (READ) | ← | ← | ← | ← | "1" output |
| SC ₁ | \bar{E} : "1" output E: high impedance | ← | ← | "1" output | \bar{E} : "1" output E: high impedance | high impedance (input) |

[Note] In mode 0, 2, 4, 6, port 3 is set to "1" output state during E = "1" and it causes the conflict with the output of external memory. Following 1 and 2 should be done to avoid the conflict:

- (1) Construct the system that disables the external memory during reset.
- (2) Add 4.7kΩ pull-down resistance to the SC₁ pin (AS) to make SC₁ pin "0" level during E = "1".
This operation makes port 3 high impedance state.

■ PIN CONDITIONS AT SLEEP AND STANDBY STATE

● Sleep State

The conditions of power supply pins, clock pins, input pins and E clock pin are the same as those of operation. Refer to Table 15 for the other pin conditions.

● Standby State

Only power supply pins and \overline{STBY} pin are active. As for the clock pin EXTAL, its input is fixed internally so the MCU is not influenced by the pin conditions. XTAL is in "1" output. All the other pins are in high impedance.

■ DIFFERENCE BETWEEN HD6301V0 and HD6301V1

The HD6301V1 is an upgraded version of the HD6301V0. The difference between HD6301V0 and HD6301V1 is shown in Table 17.

Table 17 Difference between HD6301V0 and HD6301V1

| Item | HD6301V0 | HD6301V1 |
|----------------------------|---|--|
| Operating Mode | Mode 2: Not defined | Mode 2: Expanded Multiplexed Mode (Equivalent to Mode 4) |
| Electrical Characteristics | The electrical characteristics of 2MHz version (B version) are not specified. | Some characteristics are improved. The 2MHz version is guaranteed. |
| Timer | Has problem in output compare function. (Can be avoided by software.) | The problem is solved. |

■ APPLICATION NOTE FOR HIGH SPEED SYSTEM DESIGN USING THE HD6301V1

This note describes the solutions of the potential problem caused by noise generation in the system using the HD6301V1.

The CMOS ICs and LSIs featured by low power consumption and high noise immunity are generally considered to be enough with simply designed power source and the GND line.

But this does not apply to the applications configured of high speed system or of high speed parts. Such high speed system may have a chance to work incorrectly because of the noise by the transient current generated during switching. The noise generation owing to the over current (Sometimes it may be several hundreds mA for peak level.) during switching may cause data write error.

This noise problem may be observed only at the Expanded Mode (Mode 1, 2, 4, 5 and 6) of the HD6301V1. The Single Chip Mode (Mode 7) of the HD6301V1 has no such a problem.

Assuming the HD6301V1 is used as CPU in a system.

I. Noise Occurrence

If the HD6301V1 is connected to high speed RAM, a write error may occur. As shown in Fig. 33, the noise is generated in address bus during write cycle and data is written into an unexpected address from the HD6301V1. This phenomenon causes random failures in systems whose data bus load capacitance exceeds the specification value (90 pF max.) and/or the impedance of the GND line is high.

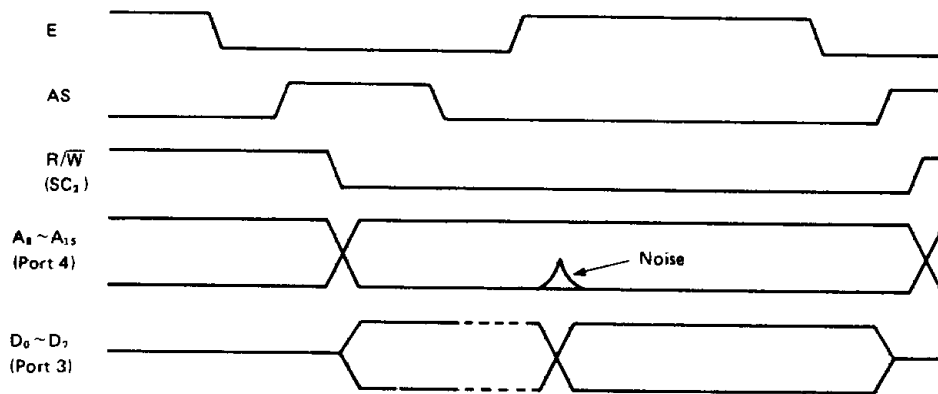


Fig. 33 Noise Occurrence in address bus during write cycle

If the data bus $D_0 \sim D_7$ changes from "FF" to "00", extremely large transient current flows through the GND line. Then the noise is generated on the LSI's V_{SS} pins proportioning to the transient current and to the impedance [Z_g] of the GND line.

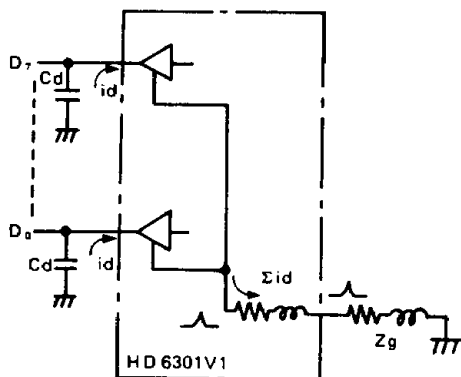
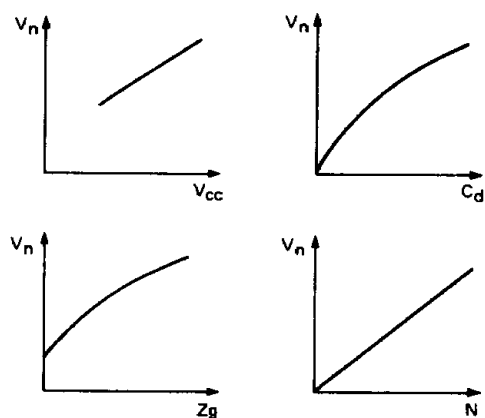


Fig. 34 Noise Source

This noise level, V_n , appears on all output pins on the LSI including the address bus.

Fig. 35 shows the dependency of the noise voltage on the each parameter.



V_n : Noise Voltage Z_g : GND Impedance
 C_d : Data bus load capacitance
 N : Number of data bus lines switching from H to L

Fig. 35 Dependency of the noise voltage on each parameter

II. Noise Protection

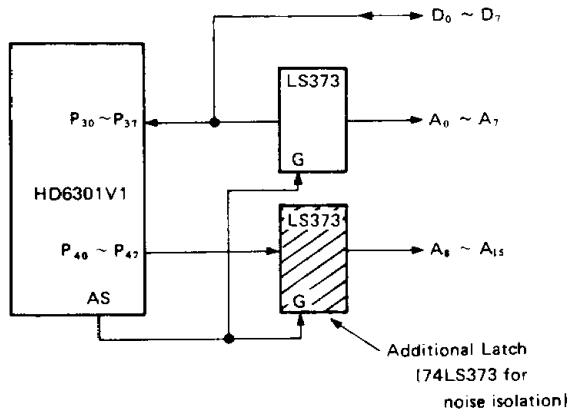
To avoid the noise on the address bus during the system operation mentioned before, there are two solutions as follows:

The one method is to isolate the HD6301V1 from peripheral devices so that peripherals are not affected by the noise. The other is to reduce noise level to the extent of not affecting peripherals using analog method.

1. Noise Isolation

Addresses should be latched at the negative edge of the AS signal or at the positive edge of the E signal. The 74LS373 is often used in this case.

HD6301V1, HD63A01V1, HD63B01V1



2. Noise Reduction

As the noise level depends on each parameter such as C_d , V_{CC} , Z_g , the noise level can be reduced to the allowable level by controlling those analog parameters.

trolling those analog parameters.

(a) Transient Current Reduction

- (1) Reduce the data bus load capacitance. If large load capacitance is expected, a bus buffer should be inserted.
- (2) Lower the power supply voltage V_{CC} within specification.
- (3) Increase a time constant at transient state by inserting a resistor ($100 \sim 200\Omega$) to Data Buses in series to keep noise level down.

Table 18 shows the relationship between a series resistors and noise level or a resistor and DC/AC characteristics.

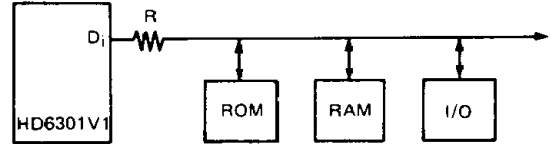


Table 18.

| Item | Resistor | No | 100Ω | 200Ω | |
|---------------------|-------------|-------------|--------|--------|--------|
| Noise Voltage Level | | See Fig. 36 | | | |
| DC Characteristics | I_{OL} | 1.6 mA | 1.6 mA | 1.0 mA | |
| AC Characteristics | f = 1 MHz | No change | | | |
| | f = 1.5 MHz | t_{ADL} | 190 ns | 190 ns | 210 ns |
| | | t_{ACCM} | 395 ns | 395 ns | 375 ns |
| | f = 2 MHz | t_{ADL} | 160 ns | 180 ns | 200 ns |
| | | t_{ASL} | 20 ns | 20 ns | 0 ns |
| | t_{ACCM} | 270 ns | 250 ns | 230 ns | |

Fig. 36 shows an example of the dependency of the noise voltage on the load capacitance of the data bus.*

*Note: The value of series resistor should be carefully selected because it heavily depends on each parameter of actual application system.

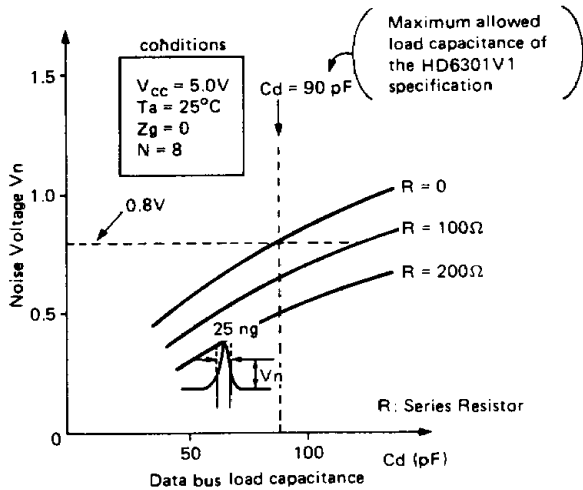


Fig. 36

Fig. 37 shows the typical wave form of the noise.

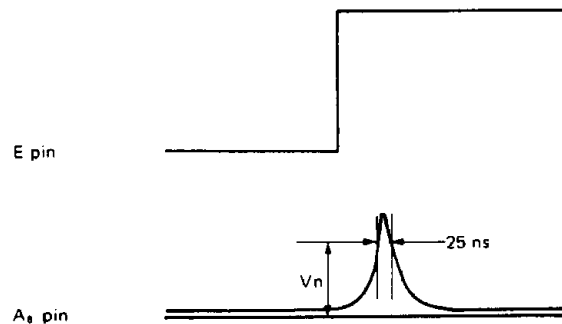


Fig. 37

(b) Reduction of GND line impedance

- (1) Widen the GND line width on the PC board.
- (2) Place the HD6301V1 close by power source.

- (3) Insert a bypass capacitor between the V_{CC} line and the GND of the HD6301V1. A tantalum capacitor (about $0.1\mu\text{F}$) is effective on the reduction.

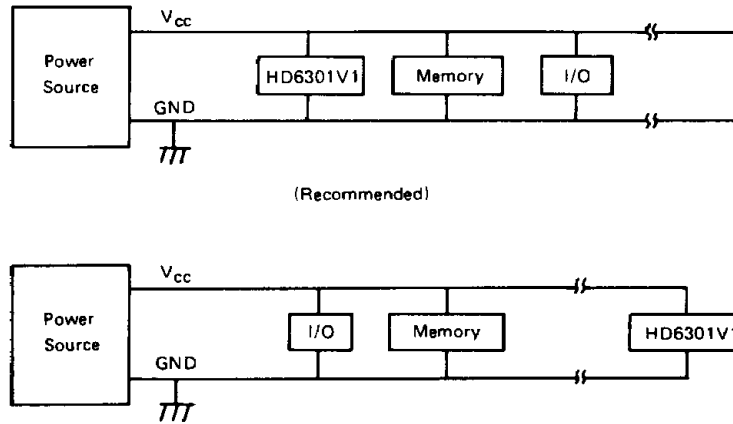


Fig. 38 Layout of the HD6301V1 on the PC board

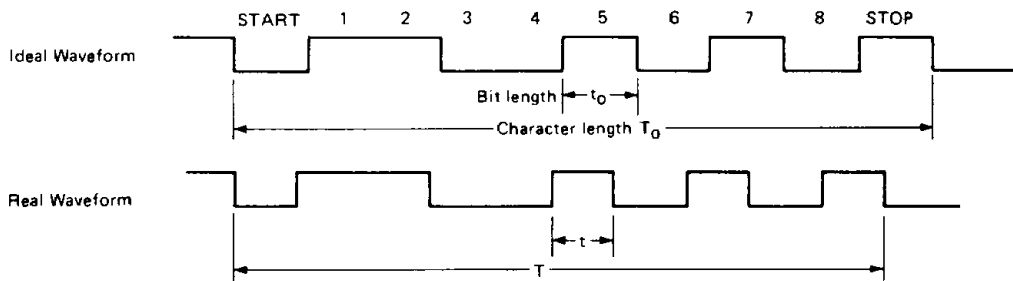
■ RECEIVE MARGIN OF THE SCI

Receive margin of the SCI contained in the HD6301V1 is shown in Table 19.

Note: SCI = Serial Communication Interface

Table 19

| Bit distortion tolerance ($t-t_0$) / t_0 | Character distortion tolerance ($T-T_0$) / T_0 |
|---|---|
| $\pm 37.5\%$ | +3.75% -2.5% |



HD6301V1, HD63A01V1, HD63B01V1

■ WARNING CONCERNING WAI INSTRUCTION

If the HALT signal is accepted by the MCU while the WAI instruction is executing, the CPU will not operate correctly after HALT mode is canceled.

WAI is an instruction which waits for an interrupt. The corresponding interrupt routine is executed after an interrupt occurs.

However, during the execution of the WAI instruction, HALT input makes the CPU malfunction and fetch an abnormal interrupt vectoring address.

In HALT mode, the CPU operates correctly without the WAI instruction, and WAI is executed correctly without HALT input. Therefore, if HALT input is necessary, make interrupts wait during the loop routine, as shown in Figure 39.

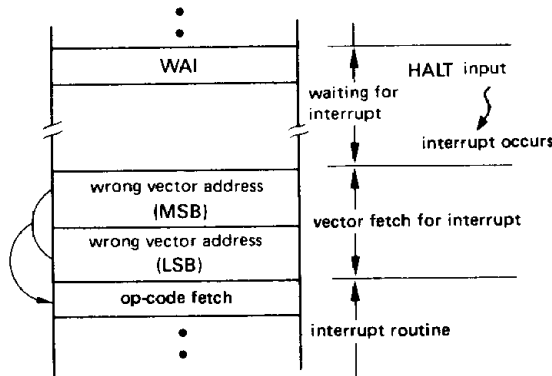


Figure 39 MAC function during WAI

■ NOTICE ON HD6301V1

The HD6301V0 (including A and B version) was upgraded to the HD6301V1 series in early 1983.

The specification deviation between the HD6301V0 series and the HD6301V1 series is as follows. Please refer to the data sheet for detailed specifications of the HD6301V1 series.

Table 20 Specification Deviation Between the HD6301V0 and the HD6301V1

| Items | HD6301V0 | HD6301V1 |
|----------------------------|--|---|
| Operating Mode | Mode 2: Not defined Mode 3: Not defined | Mode 2: Expanded multiplexed mode (equivalent to Mode 4) Mode 3: Not defined |
| Electrical Characteristics | The electrical characteristics of 2 MHz version (B version) are not specified. | The 2 MHz version is guaranteed. |
| Timer | Has problem in output compare function. (Can be avoided by software). | Fixed |

■ NOTICE ON HD6303R

The HD6303R is the same die as the HD6301V1. The on-chip Mask ROM is disabled by mask option; therefore not all modes of operation are available on the HD6303R. Please note that wherever HD6301V1 is referenced, the information also applies to the HD6303R.

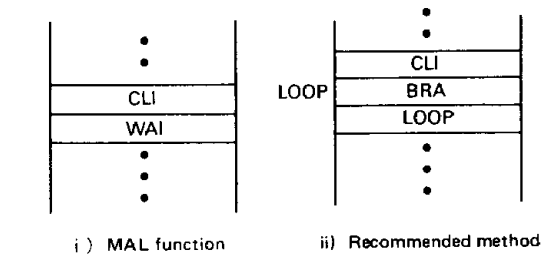


Figure 40 Program to wait for interrupt

■ WRITE-ONLY REGISTER

When the CPU reads a write-only register, the read data is always \$FF, regardless of the value in the write-only register. Therefore, be careful of the results of instructions which read a write-only register and perform an arithmetic or logical operation on its contents, such as AIM, ADD, or ROL, is executed, because the arithmetic or logical operation is always done with the data \$FF. In particular, don't use the AIM, OIM or EIM instruction to manipulate the DDR bit of PORT.

■ WARNING CONCERNING POWER START-UP

RES must be held low for at least 20 ms when the power starts up. In this case, the internal reset function is not effective until the oscillation begins at power-on. The RES signal is input to the LSI in synchronism with the internal clock ϕ (shown in Figure 41).

Therefore, after power starts up, the LSI conditions such as its I/O ports and operating mode, are unstable. Fix the level of I/O ports by means of an external circuit to determine the level for system operation during the oscillator stabilization time.

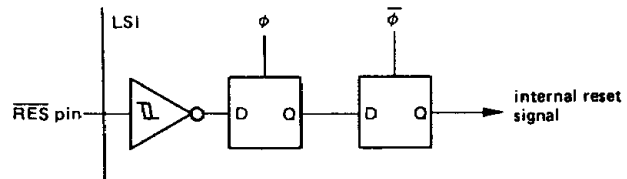


Figure 41 RES circuit

■ NOTICE ON HD6303R1

The HD6303R has been upgraded to HD6303R1. Refer to the following figures for differences between the devices. All other characteristics remain the same.

■ DIFFERENCES BETWEEN HD6301V1, HD6303R, HD6303R1, HD63P01M1, AND HD63701V0

| Item | HD6301V | HD63701V0 |
|----------------|---|---|
| RAM | <p>RAM Size: 128-byte Address: \$0080-\$00FF</p> | <p>RAM Size: 192-byte Address: \$0040-\$00FF</p> |
| Operation Mode | Mode 4: Expanded Multiplexed Mode = Mode 2 | HD63701V0 does not have Mode 4 |
| Timer | <p>After providing supply voltage, output level is undefined (0 or 1) unless the contents of the Output Compare Register matches with those of the Free Running Counter. The Output Level Register is not initialized by reset.</p> <p>Figure 20 Programmable Timer Block Diagram</p> | <p>The Output Level Register is initialized to 0 by reset.</p> <p>Figure 20 Programmable Timer Block Diagram</p> |
| SCI | <p>HD6301V1, HD6303R, HD63P01M1</p> <p>When framing error occurs, receive data is not transferred from the Receive Shift Register to Receive Data Register (RDR).</p> | <p>HD6303R1</p> <p>Receive data is transferred from Receive Shift Register to RDR even if framing error occurs.</p> |

HD6301V1, HD63A01V1, HD63B01V1

■ DIFFERENCES BETWEEN HD6301V1, HD6303R, HD6303R1, HD63P01M1, AND HD63701V0 (Continued)

| Item | HD6301V | | HD63701V0 | | | | | | | |
|--|---|---|---|--|--------------|---|--|------------|--|--------------|
| Port Reset | <p>The DDR of port is reset synchronously with E clock. I/O state is undefined from providing power supply till oscillation start (max. 20ms).</p> | | <p>The DDR of port is reset asynchronously with E clock. CPU enters into high impedance state (input state) by bringing RES Low. Reset release and MCU internal reset is performed synchronously with E clock.</p> | | | | | | | |
| Standby Mode | <p>STBY signal is latched synchronously with E clock.</p> | | <p>STBY signal is latched asynchronously with E clock. CPU enters into standby state by bringing STBY low.</p> | | | | | | | |
| AS (Address Strobe) | HD63P01M1 | HD6301V1, HD6303R, HD6303R1 | <p>During reset, AS functions normally.</p> | | | | | | | |
| | <p>In Expanded Multiplexed Mode (mode 0, 2, 4 or 6), AS becomes high impedance state for a half E clock cycle during reset. Therefore, I/O Port 3 functions as data bus during reset.</p> | <p>During reset, AS functions normally.</p> | | | | | | | | |
| SCI Receive Margin | HD6301V1, HD6303R, HD6303R1 | HD63P01M1 | <p>The SCI receive margin is shown below.</p> <table border="1"> <tr> <td>Bit distortion tolerance $(t-t_0)/t_0$</td> <td>$\pm 37.5\%$</td> </tr> <tr> <td>Character distortion tolerance $(T-T_0)/T_0$</td> <td>$\pm 3.75\%$</td> </tr> </table> | Bit distortion tolerance $(t-t_0)/t_0$ | $\pm 37.5\%$ | Character distortion tolerance $(T-T_0)/T_0$ | $\pm 3.75\%$ | | | |
| | Bit distortion tolerance $(t-t_0)/t_0$ | $\pm 37.5\%$ | | | | | | | | |
| Character distortion tolerance $(T-T_0)/T_0$ | $\pm 3.75\%$ | | | | | | | | | |
| | <p>The SCI receive margin is shown below.</p> <table border="1"> <tr> <td>Bit distortion tolerance $(t-t_0)/t_0$</td> <td>$\pm 37.5\%$</td> </tr> <tr> <td>Character distortion tolerance $(T-T_0)/T_0$</td> <td>$\pm 3.75\%$</td> </tr> </table> | Bit distortion tolerance $(t-t_0)/t_0$ | $\pm 37.5\%$ | Character distortion tolerance $(T-T_0)/T_0$ | $\pm 3.75\%$ | <p>The SCI receive margin is shown below.</p> <table border="1"> <tr> <td>Bit distortion tolerance $(t-t_0)/t_0$</td> <td>$\pm 25\%$</td> </tr> <tr> <td>Character distortion tolerance $(T-T_0)/T_0$</td> <td>$\pm 3.75\%$</td> </tr> </table> | Bit distortion tolerance $(t-t_0)/t_0$ | $\pm 25\%$ | Character distortion tolerance $(T-T_0)/T_0$ | $\pm 3.75\%$ |
| Bit distortion tolerance $(t-t_0)/t_0$ | $\pm 37.5\%$ | | | | | | | | | |
| Character distortion tolerance $(T-T_0)/T_0$ | $\pm 3.75\%$ | | | | | | | | | |
| Bit distortion tolerance $(t-t_0)/t_0$ | $\pm 25\%$ | | | | | | | | | |
| Character distortion tolerance $(T-T_0)/T_0$ | $\pm 3.75\%$ | | | | | | | | | |

HD6301V1, HD63A01V1, HD63B01V1

■ DIFFERENCES BETWEEN HD6301V1, HD6303R, HD6303R1, HD63P01M1, AND HD63701V0 (Continued)

| Item | HD6301V | | HD63701V0 | | | | | | | | | | | |
|-------------------------|--|--|---|---|-----------------------|-----|-----|-----|-----|-------------------------|-----|-----|----|----|
| | HD6301V1, HD6303R, HD6303R1 | HD63P01M1 | | | | | | | | | | | | |
| Function | Supply Voltage | $V_{CC} = 5V \pm 10\%$ (f = 0.1 ~ 2 MHz) $V_{CC} = 3 \sim 6V$ (f = 0.1 ~ 0.5 MHz) | $V_{CC} = 5V \pm 10\%$ (f = 0.1 ~ 1 MHz) | $V_{CC} = 5V \pm 10\%$ (f = 0.1 ~ 2 MHz) | | | | | | | | | | |
| | Address/Data Hold Time (t_{AH} , t_{HW}) | $t_{AH} = 20$ ns min. $t_{HW} = 20$ ns min. t_{AH} and t_{HW} are constant independently of operating frequency. | $t_{AH} = 20$ ns min. $t_{HW} = 20$ ns min. t_{AH} and t_{HW} are constant independently of operating frequency. | $t_{AH}, t_{HW} = 60$ ns (f = 1 MHz) $= 40$ ns (f = 1.5 MHz) $= 30$ ns (f = 2 MHz) t_{AH} and t_{HW} are proportion to 1/f. (f = operating frequency) | | | | | | | | | | |
| Specification | Address Delay Time | (1) t_{AD1} and t_{AD2} are constant independently of operating frequency. In HD63B01V (B version of HD6301V), t_{AD1} and t_{AD2} are 160 ns max. at 0.1 MHz through 2 MHz operation. (2) t_{ADL} is related to operating frequency. (t_{ADL} is in proportion to 1/f. f = operating frequency) | t_{AD1}, t_{AD2} and t_{ADL} are related to operating frequency (They are in proportion to 1/f. f = operating frequency). Therefore, if HD637B01V operates at lower operating frequency, t_{AD1}, t_{AD2} and t_{ADL} will become 160 ns or more. t_{AD1}, t_{AD2} and t_{ADL} are calculated as follows. t_{AD} (f MHz) ≈ 250 ns (1 MHz) $\times 1/f$ (MHz) | t_{AD1}, t_{AD2} and t_{ADL} are related to operating frequency (They are in proportion to 1/f. f = operating frequency). Therefore, if HD637B01V operates at lower operating frequency, t_{AD1}, t_{AD2} and t_{ADL} will become 160 ns or more. t_{AD1}, t_{AD2} and t_{ADL} are calculated as follows. t_{AD} (f MHz) ≈ 250 ns (1 MHz) $\times 1/f$ (MHz) | | | | | | | | | | |
| | I_{in} and C_{in} of \overline{RES} | $I_{in} = 1.0 \mu A$ max., $C_{in} = 12.5$ pF max. | | $I_{in} = 10 \mu A$ max. $C_{in} = 50$ pF max. Since \overline{RES} is multiplexed with V_{PP} , C_{in} and I_{in} are larger than those of HD6301V. | | | | | | | | | | |
| | Load Capacitance of E | 2 - LSTTL + 40pF $I_{OL} = 0.8$ mA, $I_{OH} = -200 \mu A$ | | 1 - TTL + 90pF $I_{OL} = 1.6$ mA, $I_{OH} = -200 \mu A$ | | | | | | | | | | |
| | Load Capacitance of Port 1 | 1 - TTL + 30pF | | 1 - TTL + 90pF | | | | | | | | | | |
| | Spec. of Crystal Oscillator | Spec. $R_s = 60\Omega$ max. | | Spec. <table border="1"> <tr> <td>Clock frequency (MHz)</td> <td>2.5</td> <td>4.0</td> <td>6.0</td> <td>8.0</td> </tr> <tr> <td>R_s max. (Ω)</td> <td>500</td> <td>120</td> <td>80</td> <td>60</td> </tr> </table> | Clock frequency (MHz) | 2.5 | 4.0 | 6.0 | 8.0 | R_s max. (Ω) | 500 | 120 | 80 | 60 |
| | Clock frequency (MHz) | 2.5 | 4.0 | 6.0 | 8.0 | | | | | | | | | |
| R_s max. (Ω) | 500 | 120 | 80 | 60 | | | | | | | | | | |
| Storage Temperature | $T_{stg} = -55 \sim +150^\circ C$ | | $T_{stg} = -55 \sim +125^\circ C$ | | | | | | | | | | | |



HD6301V1, HD63A01V1, HD63B01V1

■ DIFFERENCES BETWEEN HD6301V1, HD6303R, HD6303R1, HD63P01M1, AND HD63701V0 (Continued)

| | Item | HD6301V | | HD63701V0 |
|----------|---------------|---|--------------------------|--------------------------|
| Function | GND Noise | HD6301V1, HD6303R | HD6303R1, HD63P01M1 | |
| | | <p>If load capacitance in each data line and GND impedance are large, noise may appear on address bus during MCU write cycle and data won't be written into RAM correctly. The noise is caused by GND impedance which becomes large when large transient current flows into GND at High to Low transition of data line.</p> | Noise is reduced by 33%. | Noise is reduced by 50%. |
| | Miscellaneous | Chip design and manufacturing process of the HD6301V differ from those of the HD63701V0. Therefore, actual spec. and margin are different between the HD6301V and the HD63701V0. Please carefully examine your system before applying HD6301V or HD63701V0 to your system. | | |